



AO MINISTERIO PUBLICO DO ESTADO DO AMAZONAS  
PROCURADORIA-FERAL DE JUSTIÇA  
EDITAL DE PREGÃO ELETRÔNICO 4.011/2019-CPL/MP/PGJ - SRP  
Processo SEI n.º 2018.016329

# PROPOSTA ITEM 3



**AO MINISTERIO PUBLICO DO ESTADO DO AMAZONAS  
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Processo SEI n.º 2018.016329**

**DADOS DO PROPONENTE**

<b>Empresa</b>	A.L.T Trindade - ME				
<b>CNPJ</b>	30.865.611/0001-63	<b>I.E.</b>	416.092.701.112	<b>IM</b>	24.833
<b>Endereço</b>	Rua Piedade, 183 – Sala 21			<b>Bairro</b>	Centro
<b>CEP</b>	18.680-050	<b>Cidade</b>	Lençóis Paulista	<b>UF</b>	SP
<b>Fone</b>	(14) 3264-2078	<b>e-Mail</b>	licitacoes@megabytecomputadores.com.br		

**DADOS BANCÁRIOS**

<b>Banco</b>	Banco do Brasil	<b>Agencia</b>	0573-8	<b>Conta</b>	41.762-9
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**RESPONSÁVEL PARA ASSINAR O CONTRATO**

<b>Nome</b>	Ana Lea Torcineli Trindade				
<b>CPF</b>	325.651.918-04	<b>RG</b>	41.113.325-1 SSP/SP		
<b>e-Mail</b>	cristiano.gttecnologia@gmail.com		<b>Fone</b>	(14) 9 9750-0016	

Lençóis Paulista, 05 de junho de 2019



**Ana Lea Torcineli Trindade**  
Proprietária  
CPF 325.651.918-04  
RG 41.113.325-1 SSP/SP





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**PROPOSTA COMERCIAL**

Item	Qtd.	Descrição	Valor Unitário	Valor Total
03	50	<p><b>Microcomputador Tipo 3 “Notebook”</b></p> <p><b>1. PROCESSADOR – Intel I5-7200u</b></p> <p>1.1. Possui instruções do padrão AVX 2.0;</p> <p>1.2. Possui instruções do padrão SSE4.1/4.2.</p> <p>1.3. Possui instruções que implementm extensões de virtualização de hardware;</p> <p>1.4. Possui 2 (dois) núcleos de processamento;</p> <p>1.5. É capaz de processar simultaneamente 04 (quatro) threads;</p> <p>1.6. Frequencia base de 2.5Ghz;</p> <p>1.7. Possui tecnologia de controle dinâmico de frequência do processador, podendo atingir 3.1Ghz;</p> <p>1.8. Cache total de 3MB;</p> <p>1.9. Litografia de 14nm;</p> <p>1.10. TDP (Thermal Design Power) de 15w;</p> <p>1.11. Suporta memória RAM do tipo DDR4-2133Mhz;</p> <p>1.12. Possui instruções AES-NI embutidas;</p> <p><b>2. MEMÓRIA RAM – HP 2133Mhz</b></p> <p>2.1. Do tipo DDR4-2133Mhz;</p> <p>2.2. Possui um total de 08(oito) Gigabytes instalados;</p> <p>2.3. Suporta expansão para até 16 9sezesseis) Gigabytes;</p> <p><b>3. BIOS – Placa Mãe HP Chipset Intel -Versão SP86833</b></p> <p>3.1. Desenvolvida pelo mesmo fabricante do equipamento;</p> <p>3.2. Suporta atualizações por software;</p> <p>3.3. Compatível com plug-and-play;</p> <p>3.4. Suporte ACPI;</p> <p>3.5. Possui recursos de controle de permissão através de senhas, sendo uma para inicializar o computador e outra para acesso e alterações das configurações do BIOS;</p> <p>3.6. Possui opção para exportar/importar configurações;</p> <p><b>4. INTERFACES</b></p> <p>4.1. Possui 1 (uma) interface interna Serial ATA III (600);</p> <p>4.2. Possui 1(uma) interface de rede RJ45 compatível com os padrões</p>	R\$ 3.772,00	<p align="right"><b>R\$ 188.600,00</b>  <b>(Cento e oitenta e oito mil e seiscentos reais)</b></p>

A.L.T Trindade- ME

CNPJ: 30.865.611/0001-63

Rua Piedade, 183 – Sala 21 – Centro - Lencóis Paulista/SP

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	<p>10/100/1000Mbps, autosenso, full-duplex e plug-and-play, configurável totalmente por software e com função Wake-on-Lan e em funcionamento;</p> <p>4.3. Possui 1 (uma) interface de rede sem fios compatível com os padrões IEEE802.11 b/g/n/ac;</p> <p>4.4. Possui 3 (três) portas USB, sendo 1 (uma) do tipo USB 3.0;</p> <p>4.5. Possui 1 (um) porta de saída de vídeo, suportando a utilização de 2 (dois) monitores simultaneamente e independentemente;</p> <p><b>5. DISCO RÍGIDO – KINGSTON SA40037/120G</b></p> <p>5.1. Possui 1 (uma) unidade de disco rígido interna, instalada, tipo SSD;</p> <p>5.2. Utiliza interface Seral ATA 600;</p> <p>5.3. Armazenamento SSD com capacidade de 120GB e velocidade de gravação de 400MB/s;</p> <p><b>6. TELA / ADAPTADOR DE VÍDEO E DIMENSÕES</b></p> <p>6.1. Controlador de vídeo com 256MB de memória;</p> <p>6.2. Compatível com DirectX 12;</p> <p>6.3. Frequência base de 300 Mhz – HD intel <b>620</b>;</p> <p>6.4. Possui tecnologia de controle dinâmico de frequência, podendo atingir, 800MHz;</p> <p>6.5. Tela LED LCD;</p> <p>6.6. Tamanho de 14" polegadas;</p> <p>6.7. Resolução de 1366 x 768;</p> <p>6.8. Peso de 1,85Kg;</p> <p><b>7. AUDIO</b></p> <p>7.1. Áudio digital integrado, com conectores para fone de ouvido e microfone;</p> <p>7.2. Possui alto-falante embutido;</p> <p><b>8. TECLADO E MOUSE</b></p> <p>8.1. Teclado compatível com padrão ABNT-II;</p> <p>8.2. Possui dispositivo apontador sensível ao toque (touchpad) com suporte a toques múltiplos;</p> <p><b>9. ALIMENTAÇÃO E ACESSÓRIOS</b></p> <p>9.1. Acompanha cabo original do fabricante, com adaptador específico, possuindo conector de tomada elétrica no padrão brasileiro (NBR 14136:2002);</p>		
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	<p>9.2. Bateria de Lithium com 3 células e autonomia de 2 horas de uso de escritório com tela ligada;</p> <p>9.3. Acompanha mochila para transporte com segurança, de tamanho suficiente para acondicionar o equipamento e seus acessórios (fonte de alimentação e cabos), confeccionada em material resistente e impermeável;</p> <p><b>10. SISTEMA OPERACIONAL</b></p> <p>10.1. O equipamento será entregue com o sistema operacional Microsoft Windows 10 pro, em português do Brasil, pois é a versão mais atual do momento;</p> <p>10.2. A licença de uso será disponibilizada, sendo possível reinstalar o sistema, mesmo após alterações de hardware, conforme necessário, desde que seja no mesmo equipamento;</p> <p>10.3. Será fornecido recurso de "recuperação ao estado de fábrica", contendo a imagem completa do sistema em seu estado inicial, do momento da entrega/fabricação, permitindo reinstalação em caso de falhas de hardware e/ou software;</p> <p><b>11. DESEMPENHO</b></p> <p>11.1. Possui índice geral no software benchmar Sysmark SE 581 pontos;</p> <p><b>Marca:</b> HP <b>Fabricante:</b> HP <b>Série / Modelo:</b> 240/246 G6 <b>Procedencia:</b> Nacional</p> <p>Consulta Online: <a href="https://support.hp.com/br-pt/document/c05515946#AbT15">https://support.hp.com/br-pt/document/c05515946#AbT15</a></p>		
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**Validade da Proposta:** 90 (noventa) dias corridos, a contar da data da sessão deste pregão eletrônico;

**Prazo de Entrega:** 30 (trinta) dias corridos, contados a partir da data de recebimento da Nota de Empenho;

**Modo de Transporte dos Produtos:** Rodoviário;

**Garantia:** 60 meses onsite para o item 03 e 36 meses onsite para o item 04.







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**Meios de contatos para atendimento em Manaus/AM:**

- **Item 03:** Para atendimento on-site HP, o contato inicial deverá ser efetuado pelo telefone 0800-709-7751 e após testes iniciais, use necessário, um técnico será deslocado até o local em que o notebook encontra-se instalado, dentro do prazo contratado.  
Endereços para contato online: <https://support.hp.com/br-pt/contact/laptops>  
Suporte Chat: [http://www.hp.com/latam/br/servico\\_garantia/0208-soporte-chat.html](http://www.hp.com/latam/br/servico_garantia/0208-soporte-chat.html)  
Endereço para registro do produto:  
<https://register.hp.com/americas/flowPage/registration/index.do?execution=e1s1&cc=BR&lang=pt>  
Autorizada HP em Manaus/AM – Digital Informática (92) 3229-0263 (92) 98857-4805 - [marcio@digital-ma.com.br](mailto:marcio@digital-ma.com.br).
- Também temos um parceiro em Manaus que poderá realizar os serviços ou identificar defeitos apresentados para solução:  
Amazon Amazon Cell Comercio Importacao e Exportacao Ltda – Contato Marcelo (92) 98413-9300.

De acordo com a minuta do contrato, por sermos responsáveis pelo atendimento, o chamado técnico também poderá ser aberto através dos contatos abaixo, **tornando a solução mais rápida, pois enviaremos o parceiro ao local em até 48 horas úteis.**

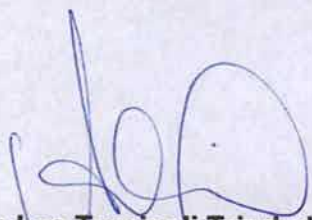
**e-Mail:** [cristiano.gttecnologia@gmail.com](mailto:cristiano.gttecnologia@gmail.com)

**Whatsapp:** (14) 997500016 (24 Horas, inclusive finais de semana)

**Responsável pelo atendimento inicial:** Cristiano

**Pagamento:** não superior a 30 (trinta) dias, contados a partir do atesto da Administração na fatura apresentada.

Lençóis Paulista, 05 de junho de 2019



**Ana Lea Torcineli Trindade**  
Proprietária  
CPF 325.651.918-04  
RG 41.113.325-1 SSP/SP





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**DECLARAÇÕES – ANEXO IV**

A empresa **A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, através de seu representante legal, Ana Lea Torcineli Trindade, portador do CPF: 325.651.918-04, DECLARA expressamente que:

1. Cumpro plenamente os requisitos de credenciamento e habilitação, inclusive o estabelecido no **subitem 4.7.1.**, para os devidos fins elencados no art. 9º e seus incisos da Lei n.º 8.666/93, e quanto ao fato de que não possuo sócios, diretores ou gerentes, que sejam cônjuge, companheiro ou parente em linha reta, colateral ou por afinidade, até o terceiro grau, inclusive, de membros ou de servidores ocupantes de cargo de direção, chefia ou assessoramento no âmbito do Ministério Público do Estado do Amazonas e de sua CPL;

2. Os documentos e declarações apresentados são fiéis e verdadeiros, bem como que a empresa recebeu o Edital e todos os documentos que o integram, dispondo de todos os elementos e informações necessários à elaboração da proposta de preços com total e completo conhecimento do objeto da licitação.

3. Estou ciente da obrigação de, caso seja vencedor do certame e não cadastrado ao SISTEMA DE ADMINISTRAÇÃO FINANCEIRA E CONTABILIDADE da SECRETARIA DA FAZENDA DO ESTADO DO AMAZONAS – SEFAZ-AM, efetuar o referido cadastramento no prazo de cinco dias úteis, a contar da adjudicação, sob pena de perder o direito de preferência à contratação em favor dos demais licitantes subsequentes, sem prejuízo da possibilidade de responder a procedimento apuratório por eventual retardamento da licitação;

4. Declaração de que o preço inclui além do lucro, todos os custos e despesas, com tributos incidentes e encargos devidos, materiais, serviços, transporte, bem como quaisquer outras despesas diretas e indiretas incidentes no fornecimento dos materiais.

Lençóis Paulista, 05 de junho de 2019



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**DECLARAÇÃO REFERENTE AO INCISO III E IV DO ARTIGO 1º E NO INCISO III DO  
ARTIGO 5º DA CONSTITUIÇÃO FEDERAL**

A empresa **A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, através de seu representante legal, Ana Lea Torcineli Trindade, portador do CPF: 325.651.918-04, DECLARA expressamente que, não possui em sua cadeia produtiva, empregados executando trabalho degradante ou forçado, nos termos do inciso III e IV do artigo 1º e no inciso III do artigo 5º da Constituição Federal.

Lençóis Paulista, 05 de junho de 2019

  
**Ana Lea Torcineli Trindade**  
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**DECLARAÇÃO DE ELABORAÇÃO INDEPENDENTE DA PROPOSTA**

A empresa **A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, através de seu representante legal, Ana Lea Torcineli Trindade, portador do CPF: 325.651.918-04, doravante denominado Licitante, declara, sob as penas da lei, em especial o art. 299 do Código Penal Brasileiro, que:

I. a proposta apresentada para participar do pregão eletrônico foi elaborada de maneira independente Licitante, e o conteúdo da proposta não foi, no todo ou em parte, direta ou indiretamente, informado, discutido ou recebido de qualquer outro participante potencial ou de fato por qualquer meio ou por qualquer pessoa;

II. a intenção de apresentar a proposta elaborada para participar do pregão eletrônico não foi informada, discutida ou recebida de qualquer outro participante potencial ou de fato por qualquer meio ou por qualquer pessoa;

III. que não tentou, por qualquer meio ou por qualquer pessoa, influir na decisão de qualquer outro participante potencial ou de fato do pregão eletrônico quanto a participar ou não da referida licitação;

IV. que o conteúdo da proposta apresentada para participar do pregão eletrônico não será, no todo ou em parte, direta ou indiretamente, comunicado ou discutido com qualquer outro participante potencial ou de fato antes da adjudicação do objeto da referida licitação;

V. que o conteúdo da proposta apresentada para participar do pregão eletrônico não foi, no todo ou em parte, direta ou indiretamente, informado, discutido ou recebido de qualquer integrante antes da abertura oficial das propostas; e

VI. que está plenamente ciente do teor e da extensão desta declaração e que detém plenos poderes e informações para firmá-la.

Lençóis Paulista, 05 de junho de 2019



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### DECLARAÇÃO ENQUADRAMENTO ME

A empresa **A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, através de seu representante legal, Ana Lea Torcineli Trindade, portador do CPF: 325.651.918-04, DECLARA sob as penas da Lei, que está enquadrada como ME e atende os dispositivos da Lei Complementar n° 123, de 14 de dezembro de 2006, notadamente o art. 3º, tendo direito aos benefícios estendidos pelo referido Diploma

Lençóis Paulista, 05 de junho de 2019

  
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### **ADOÇÃO DOS CRITÉRIOS DE SUSTENTABILIDADE**

Declaro para devidos fins licitatórios que a empresa **A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, adota os critérios de sustentabilidade conforme prevê o artigo 4º do Decreto nº 7.746 de 5 de junho de 2012, que estabelece as seguintes diretrizes:

- Os bens são constituídos no todo ou em parte, por material reciclado, atóxico, biodegradável, conforme ABNT NBR – 15448-1 e 15448-2;
- São observados os requisitos ambientais para a obtenção de certificação do Instituto Nacional de Metrologia, Normalização e Qualidade Industrial – INMETRO, como produtos sustentáveis ou de menor impacto ambiental em relação aos seus similares;
- Os bens são acondicionados em embalagem individual, adequada com menor volume possível, utilizando materiais recicláveis, de forma a garantir a máxima proteção durante o transporte e o armazenamento;
- Os bens não contêm substâncias perigosas em concentração acima da recomendada na diretiva RoHS (Restriction of Certain Hazardous Substances), tais como mercúrio (Hg), chumbo (Pb), cromo hexavalente (CR9VI), cádmio (Cd), bifenilpolibromados (PPBs), éteres bifenil-polibromados(PCDEs).

Lençóis Paulista, 05 de junho de 2019



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### **DECLARAÇÃO DE RESPONSABILIDADE AMBIENTAL**

**A.L.T. Trindade - ME**, inscrita no **CNPJ 30.865.611/0001-63**, através de seu representante legal, Ana Lea Torcineli Trindade, portador do CPF: 325.651.918-04, em atendimento à Instrução Normativa nº 01/2010 de 19 de janeiro de 2010, declara, sob as penas da lei, em especial o art. 299 do Código Penal Brasileiro, que:

- a) A proponente está ciente de sua responsabilidade ambiental e se compromete em adotar as práticas ecologicamente corretas realizando as seguintes ações:
  - Descartar o material utilizado (lâmpadas, cartuchos, recipientes de tintas, caixas de papelão), fazendo a separação dos resíduos recicláveis, tendo o cuidado necessário com acondicionamento dos materiais tóxicos: lâmpadas a base de vapor de mercúrio, sódio ou similar, cartuchos e recipientes de tintas e outros, de modo a evitar a evaporação de produtos tóxicos no meio ambiente.
  - Utilizar papéis originários de áreas de reflorestamento para reprodução de documentos;
- b) A empresa reconhece sua responsabilidade com o meio ambiente, adotando todas as medidas necessárias para evitar, atenuar ou reparar os impactos resultantes desta atividade, mantendo-se disponível à fiscalização pelos órgãos responsáveis.
- c) Que está plenamente ciente do teor e da extensão desta declaração e que detém plenos poderes e informações para firmá-la..

Lençóis Paulista, 05 de junho de 2019



**Ana Lea Torcineli Trindade**  
**Proprietária**  
**CPF 325.651.918-04**  
**RG 41.113.325-1 SSP/SP**



# HP 240/246 G6 Notebook PC



Get connected with the value-priced HP 240/246 Notebook PC. Complete business tasks with Intel® technology, essential collaboration tools and Windows 10 Pro<sup>1</sup> loaded on the HP 240. The durable chassis helps protect the notebook from the rigors of the day.



HP recommends Windows 10 Pro.

## Durable mobile design

- Rest assured that the HP 240/246 can keep up with assignments on the run. The durable chassis protects the notebook so it looks as professional as you do.

## Powered for business

- Confidently complete projects with Windows 10 Pro<sup>1</sup> and the power of the latest 7th Gen Intel® Core™ i3 or i5, processors<sup>2</sup> with optional DDR4 Memory<sup>3</sup>.

## Extras that polish the experience

- HP, a world leader in PCs helps equip you with a fully functional notebook ready to connect to all your peripherals<sup>4</sup> and designed to fit the needs of business with an RJ-45 port and VGA port.
- Help secure the future of your business. PCs from HP make the most of Windows 10 Pro<sup>1</sup> to protect you from today's security threats and maximize management and productivity features for business.
- The optional DVD Writer Drive<sup>5</sup> allows you to watch DVDs and create backups of your most important data.
- Sometimes in life, only a face-to-face conversation will do. Thanks to the HP's optional HD Webcam<sup>3</sup> with wide dynamic range (WDR) you always come off looking your best in bright and low light conditions<sup>6</sup>.
- Suppress background noise including keyboard clicks with HP Noise Cancellation Software.
- Quickly connect to your peripherals in the office or at home with legacy ports like an RJ-45 and a VGA port. Back-up and quickly move data to and from your HP 240 with the fast and convenient SD card slot.
- The firmware Trusted Platform Module (TPM)<sup>7</sup> provides hardware-based encryption keys to help secure your data, e-mail, and user credentials.
- Get fast connections with Gigabit LAN and WLAN 802.11ac/Bluetooth® 4.2 combo<sup>8</sup>.



## HP 240/246 G6 Notebook PC Specifications Table



<b>Available Operating System</b>	Windows 10 Pro 64-bit—HP recommends Windows 10 Pro. <sup>1</sup>
<b>Processor</b> <sup>2</sup>	Intel® Core™ i5 processor (5-7200U) up to 3.1GHz, 3MB de cache
<b>Available Processors</b> <sup>2,3</sup>	Intel® Core™ i7-7500U with Intel® HD Graphics 620 (2.7 GHz base frequency, up to 3.5 GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores); Intel® Core™ i5-8250U with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.4 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores); Intel® Core™ i5-7200U with Intel® HD Graphics 620 (2.5 GHz base frequency, up to 3.1 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores); Intel® Core™ i3-7020U with Intel® HD Graphics 620 (2.3 GHz, 3 MB cache, 2 cores); Intel® Core™ i3-6006U with Intel® HD Graphics 520 (2 GHz, 3 MB cache, 2 cores); Intel® Celeron® N4100 with Intel® HD Graphics 600 (1.1 GHz base frequency, up to 2.4 GHz, 4 MB cache, 4 cores); Intel® Celeron® N4000 with Intel® HD Graphics 600 (1.1 GHz base frequency, up to 2.6 GHz burst frequency, 4 MB cache, 2 cores); Intel® Celeron® N3350 with Intel® HD Graphics 500 (1.1 GHz base frequency, up to 2.4 GHz burst frequency, 2 MB cache, 2 cores); Intel® Celeron® N3050 with Intel® HD Graphics 400 (1.6 GHz base frequency, up to 2.48 GHz burst frequency, 2 MB cache, 2 cores)
<b>Chipset</b>	Chipset is integrated with processor
<b>Memory</b>	8 GB DDR4 2133MHz
<b>Internal Storage</b>	SSD 128GB - SATA III
<b>Optical Drive</b>	Optional USB
<b>Display</b>	14" diagonal HD SVA anti-glare flat LED-backlit (1366 x 768) <sup>11,13</sup>
<b>Available Graphics</b>	Intel® HD Graphics 620;
<b>Wireless Technologies</b>	Realtek 802.11b/g/n (1x1) Wi-Fi® and Bluetooth® 4.0 Combo <sup>8,9</sup>
<b>Communications</b>	GbE NIC (10/100/1000)
<b>Expansion Slots</b>	1 multi-format digital media reader (Supports SD, SDHC, SDXC)
<b>Ports and Connectors</b>	2 USB 3.1 Gen 1; 1 VGA; 1 USB 2.0; 1 RJ-45; 1 headphone/microphone combo; 1 HDMI 1.4b; 1 AC power <sup>10</sup> (HDMI cable sold separately)
<b>Input Device</b>	Full-sized island-style with numeric keypad Touchpad with multi-touch gestures enabled. Taps enabled as default
<b>Camera</b>	HP TrueVision HD camera; HP VGA camera <sup>11,12</sup>
<b>Available Software</b>	Buy Office: CyberLink Power2Go Media Player; HP ePrint; HP JumpStart; HP PC Hardware Diagnostics (UEFI); HP Support Assistant; HP System Event Utility; McAfee LiveSafe™ <sup>15</sup>
<b>Security Management</b>	Chip TPM 2.0 and Security lock slot (lock must be purchased separately)
<b>Power</b>	65 W EM Smart AC adapter, 45 W Smart AC adapter <sup>17</sup>
<b>Battery Type</b>	3-cell, 31 Wh Li-ion, 4-cell, 41 Wh Li-ion
<b>Battery Life</b>	Up to 9 hours and 30 minutes <sup>18</sup>
<b>Dimensions</b>	34 x 24 x 2.37 cm
<b>Weight</b>	Starting at 1.85 kg (Weight varies by configuration and components)
<b>Energy Efficiency Compliance</b>	ENERGY STAR® certified and EPEAT® Gold registered configurations available <sup>19</sup>
<b>Warranty</b>	Up to 5-years limited warranties. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a> . <sup>16</sup>



## HP 240/246 G6 Notebook PC

### Recommended Accessories and Services

#### HP Essential Top Load Case



The HP Essential Top Load Case is a light and durable notebook carrying case that includes high-density foam cushioning to protect your notebook (up to 15.6 diagonal inches.) while traveling between meetings or in and out of the office.

**Product number: H2W17AA**

#### HP 45W Smart AC Adapter



Be productive throughout the day and keep an extra adapter on hand with the lightweight and versatile HP 45W Smart AC Adapter.

**Product number: H6Y88AA**

#### HP Essential Combination Lock



Put your own spin on your notebook lock with the programmable HP Combination Lock, designed for any HP notebook with a standard lock slot.

**Product number: T0Y16AA**

#### HP Stereo USB Headset



Quickly and easily collaborate, chat online or listen to personal media with the crystal-clear sound and noise cancelling features of the sleek, lightweight HP Stereo USB Headset, designed to complement your professional workspace.<sup>1,2</sup>

**Product number: T1A67AA**

#### HP 3-year Travel Next Business Day Notebook Only Service



This HP services offers notebook users on the go prompt, reliable coverage in major geographies of the world, for 3 years. For more information on Care Pack services, please visit [www.hp.com/go/cpc](http://www.hp.com/go/cpc).

**Product number: UL653E**



### Messaging Footnotes

- <sup>1</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.
- <sup>2</sup> Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- <sup>3</sup> Sold separately or as an optional feature.
- <sup>4</sup> HP DVD Writer drive is sold separately or as an add-on feature. HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. 6. Requires an internet connection.
- <sup>5</sup> Requires an internet connection.
- <sup>6</sup> Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).
- <sup>7</sup> Wireless access point and internet access required. Availability of public wireless access points limited. The specifications for the BQ2.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other BQ2.11ac WLAN devices.

### Technical Specifications Footnotes

- <sup>1</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com/>.
- <sup>2</sup> Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- <sup>3</sup> In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.
- <sup>4</sup> Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.
- <sup>5</sup> For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.
- <sup>6</sup> HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.
- <sup>7</sup> Sold separately or as an optional feature.
- <sup>8</sup> Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. The specifications for the BQ2.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other BQ2.11ac WLAN devices.
- <sup>9</sup> Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: <http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast>.
- <sup>10</sup> All cables are sold separately.
- <sup>11</sup> HD content required to view HD images.
- <sup>12</sup> Internet access required.
- <sup>13</sup> Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- <sup>15</sup> Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see [www.hp.com/go/eprintcenter](http://www.hp.com/go/eprintcenter)). Print times and connection speeds may vary.
- <sup>16</sup> Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See [www.bapco.com](http://www.bapco.com) for additional details.
- <sup>17</sup> Availability may vary by country.
- <sup>18</sup> HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit [www.hp.com/go/lpc](http://www.hp.com/go/lpc). HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.
- <sup>19</sup> EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at <http://www.hp.com/go/options>

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**DECLARATION OF CONFORMITY**  
according to ISO/IEC 17050-1 and EN 17050-1

DoC #: TPN-Q186- R1 Original/en

**Manufacturer's Name:** HP Inc.  
**Manufacturer's Address:** 1501 Page Mill Road, Palo Alto, CA 94303-1112 USA

**declare, under its sole responsibility that the product**

**Product Name and Model:<sup>2)</sup>** HP 14 Laptop PC; HP 14g Laptop PC; HP 14q Laptop PC; HP Laptop; HP Laptop series; HP Laptop 14g series; HP Laptop 14q series; HP Laptop 14t series; HP 240 G6 Notebook PC; HP 240 G6; HP 246 G6 Notebook PC; HP 246 G6;

**Regulatory Model Number:<sup>1)</sup>** TPN-Q186

**Product Options:** Please See ANNEX I

**conforms to the following Product Specifications and Regulations:**

**Safety**

EN 60950-1:2006 +A11:2009 +A1:2010  
+A12:2011 +A2:2013  
IEC 60950-1:2005 +A1:2009 +A2:2013  
EN 62311:2008  
EN 62479:2010

**EMC**

EN 55032:2012 Class B  
EN 55024:2010  
EN 61000-3-2:2014  
EN 61000-3-3:2013  
EN 301 489-1 V2.1.1  
EN 301 489-17 V3.1.1  
FCC CFR 47 Part 15  
ICES-003, Issue 6

**Spectrum**

EN 300 328 V2.1.1  
EN 301 893 V2.1.0

**Ecodesign**

Regulation (EC) No. 1275/2008  
EN 50564:2011  
IEC 62301:2011

**RoHS**

EN 50581:2012

The product herewith complies with the requirements of the Radio Equipment Directive 2014/53/EU, the Ecodesign Directive 2009/125/EC, the RoHS Directive 2011/65/EU and carries the **CE**-marking accordingly.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:  
(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

**Additional Information:**

- 1) This product is assigned a Regulatory Model Number which stays with the regulatory aspects of the design. The Regulatory Model Number is the main product identifier in the regulatory documentation and test reports, this number should not be confused with the marketing name or the product numbers.
- 2) Notified Body **TUV Rheinland LGA Products GmbH** with number **0197** performed compliance assessment and issued the EU-type examination certificate with ID: RT 60119914 0001
- 3) This product was tested in a typical HP environment.

Houston, TX  
06-06-2017



*Gilles Soulard*  
Gilles Soulard, Manager  
Product Compliance Center

**Local contact for regulatory topics only:**

EU: HP Deutschland GmbH, HP HQ-TRE, 71025 Boeblingen, Germany  
U.S.: HP Inc., 1501 Page Mill Road, Palo Alto 94304, U.S.A. 650-857-1501

<http://www.hp.eu/certificates>

[Click here to go to the translation\(s\)](#)



**DECLARATION OF CONFORMITY**  
according to ISO/IEC 17050-1 and EN 17050-1

**ANNEX I**

**Regulatory Model Number: TPN-Q186**

**OPTIONS**

DESCRIPTION:*	OPTION RMN:*
Adapter	HSTNN-XA44 HSTNN-XA40 TPN-XA02 TPN-XA07 TPN-XA08 PPP009X PPP019X-X
Battery	HSTNN-XB7X HSTNN-XB7V HSTNN-XB7W HSTNN-XB6X HSTNN-XB6Y HSTNN-XB6Y HSTNN-XB8A HSTNN-XB8E
WLAN+BT Combo	RTL8723BE RTL8188EE RTL8723DE 3168NGW 7265NGW

\* Where X represents any alpha numeric character.



Ubuntu Desktop

› Search  
Results

› Detail

# Ubuntu on HP HP 14 Laptop PC/HP 240 G6 Notebook PC/HP 246 G6 Notebook PC

## Feedback

If there is an issue with the information for this system, please [let us know](#).

The HP HP 14 Laptop PC/HP 240 G6 Notebook PC/HP 246 G6 Notebook PC laptop with the components described below has been awarded the status of certified pre-install for Ubuntu.

Please note that for pre-installed systems:

1. The system is available in some regions with a special image of Ubuntu pre-installed by the manufacturer. It takes advantage of the hardware features for this system and may include additional software. You should check when buying the system whether this is an option.
2. Standard images of Ubuntu may not work at all on the system or may not work well, though Canonical and computer manufacturers will try to certify the system with future standard releases of Ubuntu.

### Ubuntu 16.04 LTS 64-bit

Pre-installed by manufacturer

### Testing details

This system was tested with 16.04 LTS, running the 4.4.0-67-generic kernel.

### Certification notes

#### MMC Cards

The card reader does not work with MMC cards. SD and SDHC cards, however, should work as expected.

#### Hibernate

Hibernate is disabled on this system

#### BIOS

Insyde: B.13 (UEFI)

## Hardware summary

This system was tested with these key components:

**Processor** Intel Intel(R) Pentium(R) CPU N3710 @ 1.60GHz



**video** Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Integrated Graphics Controller

**Ethernet** Realtek Semiconductor Co., Ltd. RTL8111/8168/8411 PCI Express Gigabit Ethernet Controller

**Wireless** Realtek Semiconductor Co., Ltd. 10ec:d723

## Hardware details

**Audio** Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Series High Definition Audio Controller

Intel Unknown

**BIOS** Insyde B.13

**Bluetooth** Realtek Semiconductor Co., Ltd. 0bda:b009

**Board** HP 8320

**Capture** Cheng Uei Precision Industry Co., Ltd (Foxlink) HP TrueVision HD Camera

**Cdrom** Aquantia Corp. hp DVDRW DA8AESH

**Chassis** HP Notebook

**Disk** Aquantia Corp. ST1000LM024 HN-M101MBB

**Efi** Insyde EFI v2.40

**Keyboard** Aquantia Corp. AT Translated Set 2 keyboard

**Mouse** Lenovo 17ef:6045

**Network** Realtek Semiconductor Co., Ltd. RTL8111/8168/8411 PCI Express Gigabit Ethernet Controller

**Processor** Intel Intel(R) Pentium(R) CPU N3710 @ 1.60GHz



<b>System</b>	HP HP Laptop 14-bs0xx
<b>Touchpad</b>	Aquantia Corp. ETPS/2 Elantech Touchpad
<b>Usb</b>	Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Series USB xHCI Controller
<b>Video</b>	Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Integrated Graphics Controller
<b>Wireless</b>	Realtek Semiconductor Co., Ltd. 10ec:d723
<b>Other</b>	Aquantia Corp. HDA Intel PCH HDMI/DP,pcm=3 Aquantia Corp. HDA Intel PCH Headphone Aquantia Corp. HDA Intel PCH Mic Aquantia Corp. HP WMI hotkeys Aquantia Corp. HP Wireless hotkeys Aquantia Corp. Lid Switch Aquantia Corp. Power Button Aquantia Corp. Video Bus Genesys Logic, Inc USB-2.0 4-Port HUB Linux Foundation 2.0 root hub Linux Foundation 3.0 root hub



(http://msdn.microsoft.com/en-US/windows/hardware/)

Home (<http://msdn.microsoft.com/en-US/windows/hardware/>)

Explore (<https://msdn.microsoft.com/en-US/windows/hardware/mt269773.aspx>)

Hardware Dev Center (<http://msdn.microsoft.com/en-US/windows/hardware/>) > Windows Compatible Products List (/en-US/Hardware/LPL/ProductDetails.aspx?ProductID=509509&OrganizationID=31)

# Windows Compatible Products List

HP 240/246 Notebook PC By

Hewlett-Packard Company

## Compatibility details

- Verification report:
- 1831959 - Certification Report - 04/18/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1831959)
  - 1831960 - Certification Report - 04/18/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1831960)
  - 1831962 - Certification Report - 04/18/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1831962)
  - 1831963 - Certification Report - 04/18/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1831963)
  - 1838352 - Certification Report - 05/06/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1838352)
  - 1838354 - Certification Report - 05/06/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1838354)
  - 1838357 - Certification Report - 05/06/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1838357)
  - 1838361 - Certification Report - 05/06/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1838361)
  - 1838362 - Certification Report - 05/06/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1838362)
  - 1847062 - Certification Report - 06/03/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1847062)
  - 1847063 - Certification Report - 06/03/2016 (/en-us/hardware/LogoVerificationReport.aspx?sid=1847063)

Compatibility status: Windows 7 x64

Certified for Microsoft Windows 10 Client family versions 1506 and 1511, x64

Product types: Keyboards, Mobile

Feature and AQ's: Windows 10 Client x64 ▾



Device.Input.Keyboard  
System.Client.Aero  
System.Client.BluetoothController.Base  
System.Client.BluetoothController.USB  
System.Client.BrightnessControls  
System.Client.Buttons  
System.Client.Camera  
System.Client.CPU  
System.Client.Firewall  
System.Client.Firmware.UEFI.GOP  
System.Client.Graphics  
System.Client.MediaTranscode  
System.Client.PCContainer  
System.Client.RadioManagement  
System.Client.SystemConfiguration  
System.Client.SystemImage  
System.Client.SystemPartition  
System.Client.VideoEncode  
System.Client.VideoPlayback  
System.Client.Webcam  
System.Client.Webcam.Specification  
System.Client.WLAN.BasicConnectivity  
System.Client.WLAN.Miracast  
System.Client.WLAN.SupportMACAddressRandomization  
System.Client.WLAN.WiFiDirect  
System.Fundamentals.Battery  
System.Fundamentals.DebugPort  
System.Fundamentals.DebugPort.USB  
System.Fundamentals.EnergyEstimation  
System.Fundamentals.Firmware  
System.Fundamentals.Firmware.Boot  
System.Fundamentals.Graphics  
System.Fundamentals.Graphics.Display  
System.Fundamentals.Graphics.Display.Firmware.VBE  
System.Fundamentals.Graphics.Display.Render  
System.Fundamentals.Graphics.HybridGraphics  
System.Fundamentals.Graphics.InternalDisplay  
System.Fundamentals.Graphics.RenderOnly  
System.Fundamentals.HAL  
System.Fundamentals.Input  
System.Fundamentals.MarkerFile  
System.Fundamentals.Network  
System.Fundamentals.NX  
System.Fundamentals.PowerManagement  
System.Fundamentals.PXE  
System.Fundamentals.Reliability  
System.Fundamentals.Security  
System.Fundamentals.SignedDrivers  
System.Fundamentals.SMBIOS  
System.Fundamentals.SystemAudio  
System.Fundamentals.SystemAudio.3rdPartyDriver  
System.Fundamentals.SystemPCIController  
System.Fundamentals.SystemUSB  
System.Fundamentals.TPM.NonCS  
System.Fundamentals.TPM20  
System.Fundamentals.USBBoot  
System.Fundamentals.USBDevice  
System.Fundamentals.WatchDogTimer  
System.Server.Base  
System.Server.Graphics  
System.Server.SMBIOS  
System.Server.SVVP  
System.Server.SystemStress  
System.Server.Virtualization  
System.Server.WHEA



### Windows Compatible Products List

#### Windows Dev Center

Windows Dev Center home  
(<https://dev.windows.com/en-US>)

Windows Store apps  
(<http://msdn.microsoft.com/en-US/windows/apps/>)

Microsoft Edge (<https://dev.windows.com/en-US/microsoft-edge-for-devs>)

Hardware Dev Center  
(<http://msdn.microsoft.com/en-US/windows/hardware/>)

#### Other links

SUPPORT (<http://msdn.microsoft.com/en-US/windows/hardware/gg454528>)

Microsoft Connect  
(<http://connect.microsoft.com/>)

OEM ([/en-us/hardware/oem](http://en-us/hardware/oem))

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## Product Criteria

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### Computers & Displays Criteria Information

#### HP 240 G6 Notebook PC - Notebooks

##### Energy conservation

Meets Criterion	Required/Optional Criterion	Criterion	*Declared Value
YES	Required	4.5.1.1 ENERGY STAR®	6.1-Computers;2291256
NO	Optional	4.5.1.2 Early adoption of new ENERGY STAR® specification	
YES	Optional	4.5.2.1 Renewable energy accessory available	
NO	Optional	4.5.2.2 Renewable energy accessory standard	

\*For some criteria, manufacturers must declare values to meet the criterion and for others the manufacturer may declare values voluntarily.

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## [EPEAT Registry](#)

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Product: HP 240 G6 Notebook PC  
 CAB: Green Electronics Council CAB  
 Country: United States  
 Product Type: Notebooks  
 Manufacturer: HP Inc.  
 URL: <http://www.hp.com>

Rating: 

Registration Date: 5/8/2017

Monitor Type: Flat Panel

Monitor Size: 21 in

Product Status:  Active

Exceptions: Product is in conformance with EPEAT only when product is configured with an operating system (except FreeDOS and Linux) and high efficiency power supply certified to the ENERGY STAR specification.

Manufacturer

Part #:

UPC:

EAN:

Consumer or Institutional: Not Indicated

---

### EPEAT Criteria Detail

---

**Yes R** 4.1.1.1 Compliance with provisions of European RoHS Directive upon its effective date

**Yes O** 4.1.2.1 Elimination of intentionally added cadmium

**Yes R** 4.1.3.1 Reporting on amount of mercury used in light sources (mg) 1,0,

**Yes O** 4.1.3.2 Low threshold for amount of mercury used in light sources

**Yes O** 4.1.3.3 Elimination of intentionally added mercury used in light sources

**Yes O** 4.1.4.1 Elimination of intentionally added lead in certain applications

**Yes O** 4.1.5.1 Elimination of intentionally added hexavalent chromium

**Yes R** 4.1.6.1 Elimination of intentionally added SCCP flame retardants and plasticizers in certain



applications

**Yes O** 4.1.6.2 Large plastic parts free of certain flame retardants classified under European Council Directive 67/548/EEC

**Yes O** 4.1.7.1 Batteries free of lead, cadmium and mercury

**Yes O** 4.1.8.1 Large plastic parts free of PVC

**Yes R** 4.2.1.1 Declaration of postconsumer recycled plastic content (%): 0.0

**No O** 4.2.1.2 Minimum content of postconsumer recycled plastic

**No O** 4.2.1.3 Higher content of postconsumer recycled plastic

**Yes R** 4.2.2.1 Declaration of renewable/bio-based plastic materials content (%): 0

**No O** 4.2.2.2 Minimum content of renewable/bio-based plastic material

**Yes R** 4.2.3.1 Declaration of product weight (lbs): 4.20 Pounds

**Yes R** 4.3.1.1 Identification of materials with special handling needs

**Yes R** 4.3.1.2 Elimination of paints or coatings that are not compatible with recycling or reuse

**Yes R** 4.3.1.3 Easy disassembly of external enclosure

**Yes R** 4.3.1.4 Marking of plastic components

**Yes R** 4.3.1.5 Identification and removal of components containing hazardous materials

**Yes O** 4.3.1.6 Reduced number of plastic material types

**Yes O** 4.3.1.7 Molded/glued in metal eliminated or removable

**Yes R** 4.3.1.8 Minimum 65 percent reusable/recyclable

**Yes O** 4.3.1.9 Minimum 90 percent reusable/recyclable

**Yes O** 4.3.2.1 Manual separation of plastics

**Yes O** 4.3.2.2 Marking of plastics

**Yes R** 4.4.1.1 Availability of additional three year warranty or service agreement

**Yes R** 4.4.2.1 Upgradeable with common tools

**Yes O** 4.4.2.2 Modular design

**Yes O** 4.4.3.1 Availability of replacement parts

**Yes R** 4.5.1.1 ENERGY STAR®: 6.1-Computers;2291256

**Yes O** 4.5.2.1 Renewable energy accessory available

**No O** 4.5.2.2 Renewable energy accessory standard

**Yes R** 4.8.1.1 Reduction/elimination of intentionally added toxics in packaging

**Yes R** 4.8.2.1 Separable packing materials

**No O** 4.8.2.2 Packaging 90% recyclable and plastics labeled

**Yes R** 4.8.3.1 Declaration of recycled content in packaging Brown papers=80-80;Other plastic packaging=0-0;Plastic film, wraps and bags=0-0;

**Yes O** 4.8.3.2 Minimum postconsumer content guidelines

**Yes O** 4.8.4.1 Provision of take-back program for packaging

**No O** 4.8.5.1 Documentation of reusable packaging

**Yes R** 4.6.1.1 Provision of product take-back service

**Yes O** 4.6.1.2 Auditing of recycling vendors

**Yes R** 4.6.2.1 Provision of rechargeable battery take-back service: RBRC Licensee

**Yes R** 4.7.1.1 Demonstration of corporate environmental policy consistent with ISO 14001

**Yes R** 4.7.2.1 Self-certified environmental management system for design and manufacturing organizations

**Yes O** 4.7.2.2 Third-party certified environmental management system for design and manufacturing organizations

**Yes R** 4.7.3.1 Corporate report consistent with Performance Track or GRI

**Yes O** 4.7.3.2 Corporate report based on GRI

---

## EPEAT Criteria Summary

---

Criteria Category Summary

Optional  
Points



4.1 <a href="#">Reduction/elimination of environmentally sensitive materials</a>	8/8
4.2 <a href="#">Materials selection</a>	0/3
4.3 <a href="#">Design for end of life</a>	5/5
4.4 <a href="#">Product longevity/life cycle extension</a>	2/2
4.5 <a href="#">Energy conservation</a>	1/2
4.6 <a href="#">End of life management</a>	1/1
4.7 <a href="#">Corporate performance</a>	2/2
4.8 <a href="#">Packaging</a>	2/4
<b>Total Optional Points:</b>	<b>21/27</b>

### **This Product is also registered in:**

- [Australia](#)
- [Belgium](#)
- [Brazil](#)
- [Canada](#)
- [China](#)
- [France](#)
- [Germany](#)
- [India](#)
- [Mexico](#)
- [New Zealand](#)
- [Poland](#)
- [Portugal](#)
- [Spain](#)
- [Sweden](#)
- [Taiwan](#)
- [United Kingdom](#)





**DECLARATION OF CONFORMITY**  
according to ISO/IEC 17050-1 and EN 17050-1

DoC #: TPN-Q186- R1 Original/en

**Manufacturer's Name:** HP Inc.  
**Manufacturer's Address:** 1501 Page Mill Road, Palo Alto, CA 94303-1112 USA

**declare, under its sole responsibility that the product**

**Product Name and Model:<sup>2)</sup>** HP 14 Laptop PC; HP 14g Laptop PC; HP 14q Laptop PC; HP Laptop; HP Laptop series; HP Laptop 14g series; HP Laptop 14q series; HP Laptop 14t series; HP 240 G6 Notebook PC; HP 240 G6; HP 246 G6 Notebook PC; HP 246 G6;

**Regulatory Model Number:<sup>1)</sup>** TPN-Q186

**Product Options:** Please See ANNEX I

**conforms to the following Product Specifications and Regulations:**

**Safety**

EN 60950-1:2006 +A11:2009 +A1:2010  
+A12:2011 +A2:2013  
IEC 60950-1:2005 +A1:2009 +A2:2013  
EN 62311:2008  
EN 62479:2010

**EMC**

EN 55032:2012 Class B  
EN 55024:2010  
EN 61000-3-2:2014  
EN 61000-3-3:2013  
EN 301 489-1 V2.1.1  
EN 301 489-17 V3.1.1  
FCC CFR 47 Part 15  
ICES-003, Issue 6

**Spectrum**

EN 300 328 V2.1.1  
EN 301 893 V2.1.0

**Ecodesign**

Regulation (EC) No. 1275/2008  
EN 50564:2011  
IEC 62301:2011

**RoHS**

EN 50581:2012

A certificação EN55032-2012 Class B é equivalente ao CISPR32, engloba o CISPR22 ou seja, é superior ao solicitado.

Consultem o link abaixo para comprovar a informação

<https://celectronics.com/training/learning/method/CISPR32.html>

The product herewith complies with the requirements of the Radio Equipment Directive 2014/53/EU, the Ecodesign Directive 2009/125/EC, the RoHS Directive 2011/65/EU and carries the **CE**-marking accordingly.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:  
(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

**Additional Information:**

- 1) This product is assigned a Regulatory Model Number which stays with the regulatory aspects of the design. The Regulatory Model Number is the main product identifier in the regulatory documentation and test reports, this number should not be confused with the marketing name or the product numbers.
- 2) Notified Body **TUV Rheinland LGA Products GmbH** with number **0197** performed compliance assessment and issued the EU-type examination certificate with ID: RT 60119914 0001
- 3) This product was tested in a typical HP environment.

Houston, TX  
06-06-2017

 HP Inc.  
Gilles Soulard  
Gilles Soulard, Manager  
Product Compliance Center

**Local contact for regulatory topics only:**

EU: HP Deutschland GmbH, HP HQ-TRE, 71025 Boeblingen, Germany  
U.S.: HP Inc., 1501 Page Mill Road, Palo Alto 94304, U.S.A. 650-857-1501

<http://www.hp.eu/certificates>



**BUREAU VERITAS**  
Certification



→ **HP INC.**

APPENDIX TO CERTIFICATE NO. : US012100-1

→ **ISO 14001:2015**

*Certified Locations*

SITE	ADDRESS	SCOPE
PUERTO RICO	HIGHWAY 110 NORTH KM, 28 BUILDING #2 AGUADILLA, PUERTO RICO 00603	INK LARGE FORMAT AND SUPPLIES, 3D, INKJET CARTRIDGES AND HEMI PRODUCTS MANUFACTURING. R&D, CONTROL TOWERS AND FACILITIES SUPPORT OPERATIONS.
BRAZIL	HPI BRASIL: HP BRASIL INDUSTRIA E COMERCIO EQUIPAMENTOS ELECTRONICOS ALAMENDA XINGU 350, ALPHAVILLE INDUSTRIAL- BARUERI/SP	BRAZIL TS, PPS, SALES & SUPPLY CHAIN OFFICES, BACK OFFICES & FACILITIES SUPPORT OPERATIONS
BARCELONA	CAMI DE CAN GRAELLS, 1-21, 08174 SANT CUGAT DEL VALLES (BARCELONA), SPAIN	LARGE FORMAT PRINTING (LFP) AND 3D PRINTING (3DP) DESIGN, PROTOTYPING AND TESTING; DEMO & TRAINING CENTER FOR GRAPHICS SOLUTIONS BUSINESS (GSB), LFP AND 3DP; ADMIN OFFICES AND FACILITIES SUPPORT OPERATIONS

Version: 1

Signed on behalf BVCH SAS – UK Branch

Certification body address: 5th Floor, 66 Prescot Street, London E1 8HG, United Kingdom  
Local office: 16800 Greenspoint Park Drive, Suite 300S, Houston, Texas USA

Further clarifications regarding the scope of this certificate and the applicability of the management system requirements may be obtained by consulting the organisation. To check this certificate validity please call: +(800) 937-9311





## Product Criteria

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### Computers & Displays Criteria Information

#### HP 240 G6 Notebook PC - Notebooks

##### Corporate performance

Meets Criterion	Required/Optional Criterion	Criterion	*Declared Value
YES	Required	4.7.1.1 Demonstration of corporate environmental policy consistent with ISO 14001	
YES	Required	4.7.2.1 Self-certified environmental management system for design and manufacturing organizations	
YES	Optional	4.7.2.2 Third-party certified environmental management system for design and manufacturing organizations	
YES	Required	4.7.3.1 Corporate report consistent with Performance Track or GRI	
YES	Optional	4.7.3.2 Corporate report based on GRI	

\*For some criteria, manufacturers must declare values to meet the criterion and for others the manufacturer may declare values voluntarily.

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## HP's Compliance with Restriction of Hazardous Substances (RoHS) Legislation

*(rev13 June 2014)*

HP is committed to compliance with all applicable laws and regulations, including any new material restriction requirements that may be adopted under the European Union Recast RoHS Directive, otherwise known as EU RoHS 2, the European Union's restriction of PAHs in Annex XVII of the EU REACH Regulation and China's Management Methods for Controlling Pollution by Electronic Information Products, otherwise known as China RoHS 2

HP believes that legislation, like the EU RoHS Directives, plays an important role in promoting industry-wide transition to restrict substances of concern. In general, the restriction of any substance should take into account the following key items:

- Global harmonization of the legislation content and implementation requirements
- Substance risk assessment, including a clear understanding of the environmental impacts of alternative substances
- Clear identification of what substances (vs. broad classes or categories) are to be restricted
- Clear identification of when alternative technologies are proven and readily available
- Appropriate lead time to allow the industry to transition
- Substances that are not used or found in final products should not be included in the restrictions
- Material application exemptions should be allowed for the use of restricted substances in applications where current substitution is not technically feasible
- Inclusion of maximum concentration values setting de minimis levels below which the relevant substances may be present

HP fully supports the restriction of the four substances identified by the Commission in its December 3rd, 2008 proposal for a revision of the RoHS Directive, specifically:

- Hexabromocyclododecane (HBCDD)
- Bis (2-ethylhexyl) phthalate (DEHP)
- Butyl benzyl phthalate (BBP)
- Dibutylphthalate (DBP)



HP believes other substances should be considered for inclusion in future RoHS legislation. This includes the restriction of polyvinyl chloride (PVC) and brominated flame retardants (BFRs) from electrical and electronic products (EEE). HP believes PVC and BFRs should be the focus for the restriction of chlorine (Cl) and bromine (Br) from electrical and electronic products, where technically feasible. HP's reasons for focusing on PVC and BFRs are:

- PVC and BFRs cover 99% of the uses for Cl and Br in electronics;
- Given the high percentage usage, these substances have the highest impact;
- Restriction of these substances where technically feasible would substantially accomplish the goal to eliminate Cl and Br from electronic products

By July 2007, all PVC and BFRs were restricted<sup>[1]</sup> from the external case plastics in HP branded products. In 2013, all of HP's notebook products and 60% of our desktop computer products were low-halogen.<sup>[2]</sup> When technically feasible, we will continue to phase out brominated flame retardants (BFRs), polyvinyl chloride (PVC), and phthalates to meet market demands and customer expectations. Unfortunately, it was not practical for HP or the industry as a whole to make these material transitions in all the many types of products at this time. However HP believes restriction under RoHS legislation may be possible in 2016, provided that some critical issues can be overcome or addressed by specific exemptions, including:

- For some specific applications technical issues still exist:
  - Electrical performance issues above 1 GHz in Halogen-free printed circuit boards
    - Dielectric loss
    - Unpredictability of technical performance
  - Safety issues in high temperature areas
- Availability issues for environmentally-preferable alternatives
- Transition to new substances for high performance products with long life-cycles
- Ability to maintain high recycled content as substances are restricted.

HP is taking a proactive approach to evaluating materials in its products to assess environmental, health or safety risks. HP may restrict substances because of customer or legal requirements, or because HP believes it is appropriate based on a precautionary approach. HP strives to replace legally permitted materials when scientific data have established a potential health or environmental risk and lower risk, commercially and technically viable alternatives are available. At HP the evaluation of alternative materials is a continuous process.



Our continued internal voluntary goal is to apply the EU RoHS 2 substance and exemption requirements outside the EU (and EFTA) on a worldwide basis within 6 months of each of the EU's various legal compliance dates for virtually all HP branded new products in the scope of EU RoHS 2, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive). This was achieved for 2013.

In early 2003, a company-wide RoHS team was formed to manage all aspects of HP's global response to all the RoHS legislations around the world. HP's initiative to address the RoHS legislations is part of the company's Design for Environment program, which includes using materials more efficiently, finding alternatives for designated materials, designing for energy efficiency, and designing products that can be easily recycled.

HP continues to plan for further "RoHS like" legislation in other jurisdictions and will meet any additional requirements that arise. HP complies with the requirements of the all RoHS legislations currently in effect (including those specifically listed under Compliance Status below). HP's Compliance Verification is based on our risk analysis of restricted substances entering the supply chain and includes technical documentation outlined in the European Union's EN 50581:2012 standard.

More detailed information can be found at [www.hp.com/environment](http://www.hp.com/environment):

[Living Progress Report](#)  
[Design for environment](#)  
[Compliance Verification](#)  
[General Specifications for the Environment](#)  
[Eco Declarations](#)

### **HP's Compliance Status to EXISTING RoHS Legislation:**

#### India

- HP products<sup>(3)</sup> including print cartridges comply with the material restrictions of India's legislation "E-waste (Management and Handling) Rules, 2011", otherwise known as India RoHS which came into effect on May 1, 2014.

#### European Union

- HP products in-scope and put on the market in the EU and EFTA Member States comply with the changes to exemptions required as of January 1, 2013 in Annex III of EU RoHS Directive (2011/65/EU) of 8 June 2011 and earlier Commission Decisions withdrawing exemptions.



#### Korea

- HP products<sup>[3]</sup> comply with Korea's legislation "The Act for Resource Recycling of Electrical/Electronic Products and Automobiles", otherwise known as Korean RoHS which came into effect on January 1, 2008. Korea's RoHS 2 which came into effect on January 1, 2013. HP products<sup>[3]</sup> will comply. You can find HP's Korean RoHS declarations at: [www.hp.com/go/korearohs](http://www.hp.com/go/korearohs).

#### Vietnam

- HP products<sup>[3]</sup> comply with Vietnam's legislation "Circular 30/2011/TT-BCT: Temporarily regulating the permitted limits for a number of hazardous substances in electric and electronic products", otherwise known as Vietnam RoHS which came into effect on December 1, 2012. You can find HP's Vietnam RoHS declarations at: <http://www8.hp.com/us/en/hp-information/environment/msds-specs-more.html>

#### Serbia

- HP products<sup>[3]</sup> comply with Serbia's WEEE and RoHS "Regulations on the List of Electrical and Electronic Products, Measures Banning and Restricting the Recovery of Electrical and Electronic Equipment Containing Hazardous Materials, and the Methods and Procedures for Managing Waste from Electrical and Electronic Products" that entered into force on January 4, 2011. RoHS restrictions apply to equipment placed on the market on or after July 1, 2011.

#### Ukraine

- HP products<sup>[3]</sup> comply with the substance restrictions in Ukraine's "Technical Regulation on restrictions as to the use of some dangerous substances in electric and electronic devices", otherwise known as Ukraine RoHS which came into effect on 1 January 2011.

#### New Jersey

- HP products<sup>[3]</sup> comply with New Jersey's "Electronic Waste Recycling Act" (Senate Bill 2144), otherwise known as New Jersey RoHS which came into effect on 1 January 2011.

#### Turkey

- HP products<sup>[3]</sup> comply with Turkey's "Regulation on the Restriction of the use of Certain Hazardous Substance in Electrical and Electronic Equipment", otherwise known as Turkey RoHS which came into effect on March 30, 2009.

#### China

- HP products<sup>[3]</sup> comply with China's, "Management Methods for Controlling Pollution by Electronic Information Products", otherwise known as China RoHS which came into effect on March 1, 2007.



#### California

- HP products<sup>[3]</sup> comply with California's, "Electronic Waste Recycling Act of 2003 (Senate Bill 20) substance restrictions", otherwise known as California RoHS which came into effect on January 1, 2007.

#### Worldwide

- HP continues to achieve its internal voluntary goal to meet the substance restrictions of the EU RoHS legislation on a worldwide basis, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive), for virtually all HP branded products in scope of the directive.

#### Japan

- HP products<sup>[3]</sup> comply with the labeling requirements set out in Japan's "The Marking of Presence of the Specific Chemical Substances for Electrical and Electronic Equipment" (JIS-C-0950), otherwise known as J-MOSS which came into effect on July 1, 2006. You can find HP's J-MOSS declarations at - [www.hp.com/go/iisc0950](http://www.hp.com/go/iisc0950)

#### Notes:

[1] See [HP's General Specification for the Environment](#) Identification Numbers: 041210-80 and 070905-88.

[2] External components such as keyboards, mice, cables, and cords are not low-halogen.

[3] HP products that are both in scope and put on the market in the given jurisdiction.

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## Product Criteria

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### Computers & Displays Criteria Information

#### HP 240 G6 Notebook PC - Notebooks

#### Reduction/elimination of environmentally sensitive materials

Meets Criterion	Required/Optional Criterion	Criterion	*Declared Value
YES	Required	4.1.1.1 Compliance with provisions of <b>European RoHS Directive upon its effective date</b>	
YES	Optional	4.1.2.1 Elimination of intentionally added cadmium	
YES	Required	4.1.3.1 Reporting on amount of mercury used in light sources (mg)	Light source(s) contain no mercury
YES	Optional	4.1.4.1 Elimination of intentionally added lead in certain applications	
YES	Optional	4.1.5.1 Elimination of intentionally added hexavalent chromium	
YES	Optional	4.1.3.2 Low threshold for amount of mercury used in light sources	
YES	Required	4.1.6.1 Elimination of intentionally added SCCP flame retardants and plasticizers in certain applications	
YES	Optional	4.1.6.2 Large plastic parts free of certain flame retardants classified under European Council Directive 67/548/EEC	
YES	Optional	4.1.7.1 Batteries free of lead, cadmium and mercury	
YES	Optional	4.1.8.1 Large plastic parts free of PVC	
YES	Optional	4.1.3.3 Elimination of intentionally added mercury used in light sources	

\*For some criteria, manufacturers must declare values to meet the criterion and for others the manufacturer may declare values voluntarily.

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para empresas

Suporte



## Reciclagem de Baterias

### Informações da empresa

Sustentabilidade e

Reciclagem

» Reciclagem

» Desenvolvimento de

Produtos HP

HP Eco Solutions

» Consumer

» Enterprise

» Política de Saúde  
Segurança e Meio  
ambiente» Reciclagem de  
Equipamentos» **Reciclagem de Baterias**» Reciclagem de  
Suprimentos de  
Impressão

### O que pode ser enviado para a reciclagem:

Baterias de Produtos HP de qualquer tamanho.

### Exemplos de Produtos:

Notebooks, iPAQ's, Calculadoras, Câmeras digitais, Servidores, UPS.

### Como é o processo de reciclagem:

O Programa de Reciclagem de acessórios de Produtos HP, existe desde 2002 e integra a Gestão Ambiental implantada pela empresa em todo o Brasil.

Os acessórios, como por exemplo, as baterias utilizadas em nossos produtos são fabricados com ions de lítio e isentos de controle pelo IBAMA (Instituto Brasileiro de Meio Ambiente e dos Recursos Naturais Renováveis).

A HP, por seu compromisso com o Meio Ambiente, disponibiliza um processo gratuito de devolução de acessórios e garante a destinação adequada para a reciclagem.

O processo de reciclagem dos acessórios de notebooks, iPAQs, calculadoras e câmeras digitais HP consiste no envio destes produtos para o Centro de Reciclagem da HP Brasil que é certificado e controlado por órgãos ambientais, para garantir a qualidade do processo de reciclagem e evitar qualquer eventual dano à saúde e ao planeta.

Na reciclagem, os acessórios são cortados e moídos. O pó metálico proveniente deste processo passa por reações químicas, filtragem e prensa para separar os resíduos líquidos dos sólidos. O resultado dessa separação são sais e óxidos metálicos que podem ser utilizados na fabricação de outros produtos comerciais.

Notebooks, iPAQ's, calculadoras, câmeras digitais, servidores e UPS podem ser reciclados.

Para solicitar sua reciclagem, acesse os links abaixo e preencha o formulário referente ao tipo de acessório que deseja disponibilizar.

### Para solicitar a coleta de baterias acesse:

- » Baterias de notebooks, iPAQs, calculadoras, câmeras digitais
- » Baterias de servidores e UPS.

País/Região : Brasil

### Sobre nós

Fale com a HP

Carreiras

Relações com Investidores

Impacto sustentável

Relações Públicas (POR)

A Oficina

### Como comprar

Localizador de lojas

Ligue para um revendedor

HP

Encontre um revendedor

### Suporte

Download de drivers

Suporte e solução de

problemas

Comunidade

Registrar seu produto

Verificar o status do reparo

### Parceiros da HP

Programa HP Partner First

Portal dos parceiros

Desenvolvedores

### Permaneça conectado

Inscreva-se para notícias e  
ofertas

Gerenciamento do Trusted Platform Module (TPM) no Computador Local

Arquivo Ação Exibir Janela Ajuda

Gerenciamento do TPM no Compu...

Gerenciamento do TPM no Computador Local



Gerenciamento do TPM no Computador Local  
Configura o TPM e o suporte que a plataforma Windows oferece a ele

#### Visão Geral

Os computadores Windows que contêm o Trusted Platform Module (TPM) oferecem recursos de segurança avançados. Esse snap-in exibe informações sobre o TPM do computador e permite que os administradores gerenciem o dispositivo.

#### Status

O TPM está pronto para uso.

#### Opções disponíveis

Você pode limpar o TPM para remover a propriedade e redefini-lo com os padrões de fábrica.

#### Informações sobre o Fabricante do TPM

Nome do Fabricante: INTC

Versão do Fabricante: 11.6.25.1229

Versão de Especificação: 2.0

#### Ações

Gerenciamento do TPM no Computad...

Preparar TPM...

Limpar TPM...

Exibir

Nova Janela a Partir Daqui

Atualizar

Ajuda





## Reciclagem de Produtos HP – Hardware

### Informações da empresa

#### Sustentabilidade e Reciclagem

- » Reciclagem
- » Desenvolvimento de Produtos HP
- » Suprimentos de impressão
- » Consumer
- » Enterprise
- » Política de Saúde Segurança e Meio ambiente
- » Reciclagem de Baterias

#### Informações adicionais

- » Cidadania Global HP
- » Resultados de Sustentabilidade Ambiental HP Brasil - 2009
- » Vídeo Programa de Sustentabilidade Ambiental HP
- » Notícias e eventos

#### Saiba mais

- » Perguntas de clientes e parceiros
- » Perguntas da imprensa



A HP incentiva seus clientes a descartarem seus equipamentos antigos e obsoletos de forma ambientalmente correta e segura através de seu Programa de Reciclagem e Campanhas de Trade In.

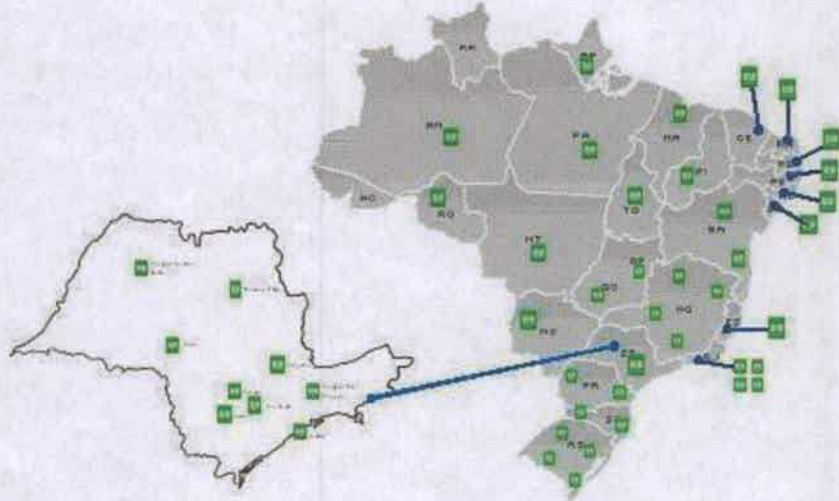
Trade-in é um termo consagrado utilizado para definir o método de compra de um produto novo, no qual se entrega um item usado como parte do pagamento. Todos os equipamentos eletrônicos descartados pelos clientes nestas campanhas realizadas ao longo do ano pela HP Brasil, são destinados à reciclagem.

Você também pode direcionar seu produto para o Programa de Reciclagem da HP Brasil, enviando um e-mail para [reciclagem@hp.com](mailto:reciclagem@hp.com) com modelo do seu equipamento, quantidade e localidade onde se encontra. Entraremos em contato para informar como descartá-lo.


Até serem, de fato, reciclados, todos os equipamentos passam por um processo rígido de desmontagem, separação de suas partes segundo o tipo (plástico, metal, borracha) e trituração. Depois de triturados, os resíduos são transformados em matéria-prima e reinseridos na cadeia produtiva de outros novos produtos.

Este Programa inovador, faz parte do compromisso ambiental da HP e oferece a nossos clientes a oportunidade em contribuir com a redução do impacto no meio ambiente e adquirirem produtos HP sustentáveis.

Regiões disponíveis para descartes de equipamentos. Consulte como realizar através do e-mail: [reciclagem@hp.com](mailto:reciclagem@hp.com).



Para saber mais, contate-nos pelo email: [reciclagem@hp.com](mailto:reciclagem@hp.com)

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# THE ECO DECLARATION

## Product environmental attributes – THE ECO DECLARATION

The declaration may be published only when all rows and/or fields marked with an \* are filled-in (n.a. for not applicable).  
Additional information regarding each item may be found under P14.


Brand *	HP	
Company name *	HP	
Contact information *	HP Sustainability and Compliance Center <a href="mailto:sustainability@hp.com">sustainability@hp.com</a>	
Internet site *	<a href="http://www.hp.com/hpinfo/globalcitizenship/environment/">http://www.hp.com/hpinfo/globalcitizenship/environment/</a>	
Additional information		

The company declares (based on product specification or test results based obtained from sample testing), that the product conforms to the statements given in this declaration.	
Type of product *	Notebook PC
Commercial name *	HP 240 G6 Notebook PC
Model number *	240 G6
Issue date *	5/5/2017
Intended market *	<input checked="" type="checkbox"/> Global <input type="checkbox"/> Europe <input type="checkbox"/> Asia, Pacific & Japan <input type="checkbox"/> Americas <input type="checkbox"/> Other
Additional information	

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

Quality Control		Requirement met	
Item		Yes	No
QC1 *	The company enforces an internal quality control scheme to ensure the correctness of this eco declaration	<input checked="" type="checkbox"/>	<input type="checkbox"/>
QC2 *	The company is a member of an eco declaration system that enforces regular independent quality control such as organized by IT-Företagen (see <a href="http://www.itcodeclaration.org">www.itcodeclaration.org</a> ).	<input checked="" type="checkbox"/>	<input type="checkbox"/>




Model number *	240 G6	Logo	
Issue date *	5/5/2017		

Product environmental attributes - Legal requirements		Requirement met		
Item		Yes	No	n.a.
<b>P1</b>	<b>Hazardous substances and preparations</b>			
P1.1*	Products do not contain more than; 0.1% lead, 0.01% cadmium, 0.1% mercury, 0.1% hexavalent chromium, 0.1% polybrominated biphenyls (PBB) or 0.1% polybrominated diphenyl ethers (PBDE). (See legal reference and Note B1)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P1.2*	Products do not contain Asbestos (see legal reference). Comment: Legal reference has no maximum concentration value.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P1.3*	Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorocarbons (HCFC), Halons, carbontetrachloride, 1,1,1-trichloroethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum concentration values.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P1.4*	Products do not contain more than; 0.005% polychlorinated biphenyl (PCB), 0.005% polychlorinated terphenyl (PCT) in preparations (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P1.5*	Products do not contain more than 0.1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P1.6*	Textile and leather parts with direct skin contact do not contain Tri-(2,3-dibromopropyl)-phosphate (TRIS), Tris-(aziridinyl)-phosphineoxide (TEPA), polybrominated biphenyl (PBB) (see legal reference). Comment: Legal reference has no maximum concentration values.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P1.7*	Textile and leather parts with direct skin contact do not contain more than 0.003% Azo colorants that split aromatic amines. (See legal reference and Note B1)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P1.8*	Wooden parts do not contain arsenic and chromium as a wood preservation treatment as well as pentachlorophenol and derivatives (see legal reference). Comment: Legal reference has no maximum concentration values.	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P1.9*	Parts with direct and prolonged skin contact do not release nickel in concentrations above 0.5 microgram/cm <sup>2</sup> /week (see legal reference). Comment: Max limit in legal reference when tested according to EN1811:1998.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P1.10*	REACH Article 33 information about substances in articles is available at (add URL or mail contact): <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/productdata/reachdesktop-pcs.html">http://www.hp.com/hpinfo/globalcitizenship/environment/productdata/reachdesktop-pcs.html</a>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P2</b>	<b>Batteries</b>			
P2.1*	If the product contains a battery or an accumulator, it is labeled with the disposal symbol and if it contains more than 0.0005% of mercury (for button cells only) by weight, or more than 0.004% of lead, it shall be marked with the chemical symbol for the metal concerned, Hg or Pb. Information on proper disposal is provided in user manual. (See legal reference)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P2.2*	Button cells used in the product do not contain more than 2% by weight of mercury. Other batteries or accumulators do not contain more than 0.0005% of mercury or 0.002% of cadmium. (See legal reference)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P2.3*	Batteries and accumulators are easily removable by either users or service providers (as dependent on the design of the product). Exception: Batteries that are permanently installed for safety, performance, medical or data integrity reasons do not have to be "easily removable". (See legal reference)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P3</b>	<b>Safety, EMC connection to the telephone network and labeling</b>			
P3.1*	The product complies with legally required safety standards as specified (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P3.2*	The product complies with legally required standards for electromagnetic compatibility (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P3.3*	If product is intended for connection to a public telecom network or contains a radio transmitter, it complies with legally required standards for radio and telecommunication devices (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P3.4*	The product is labeled to show conformance with applicable legal requirements (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P4</b>	<b>Consumable materials</b>			
P4.1*	If a photo conductor (drum, belt etc.) is used in the product, it does not contain cadmium max 0.01% (see legal reference and Note B1).	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P4.2*	If ink/toner is used in the product, it does not contain cadmium max 0.1% by weight (see legal reference).	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P4.3*	If the ink/toner formulation/preparation is classified as hazardous according to applicable regulations, the product/packaging is adequately labeled and a Safety Data Sheet (SDS) in accordance with these requirements is available (see legal reference).	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
<b>P5</b>	<b>Product packaging</b>			
P5.1*	Packaging and packaging components do not contain more than 0.01% lead, mercury, cadmium and hexavalent chromium by weight of these together.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	
P5.2*	Plastic packaging material is marked according to ISO 11469 referring ISO 1043 (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P5.3*	The product packaging material is free from ozone depleting substances as specified in the Montreal Protocol (see legal reference). Comment: Legal reference has no maximum concentration values.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>

Note B1: Restriction applies to the homogeneous material, unless other specified and expressed in weight %.




Model number *	240 G6		
Issue date *	5/5/2017	Logo	

Product environmental attributes - Market requirements - Environmental conscious design		Requirement met		
Item	*=mandatory to fill in. Additional information regarding each item may be found under P14.	Yes	No	n.a.
<b>P6 Treatment information</b>				
P6.1*	Information for recyclers/treatment facilities is available (see legal reference).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P7 Design</b>				
<b>Disassembly, recycling</b>				
P7.1*	Parts that have to be treated separately are easily separable	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.2*	Plastic materials in covers/housing have no surface coating.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.3*	Plastic parts >100g consist of one material or of easily separable materials.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.4*	Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.5	Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.6*	Labels are easily separable. (This requirement does not apply to safety/regulatory labels).	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>Product lifetime</b>				
P7.7*	Upgrading can be done e.g. with processor, memory, cards or drives	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.8*	Upgrading can be done using commonly available tools	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.9.	Spare parts are available after end of production for: 5 years			<input type="checkbox"/>
P7.10	Service is available after end of production for: years			<input checked="" type="checkbox"/>
<b>Material and substance requirements</b>				
P7.11*	Product cover/housing material type: Material type: <b>PC/ABS+15%TALC</b> Material type: <b>PC/ABS+5%TALC</b> Material type:			
P7.12	Electrical cable insulation materials of power cables are PVC free.	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
P7.13	Electrical cable insulation materials of signal cables are PVC free	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.14	All cover/housing plastic parts >25g are free from chlorine and bromine.	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
P7.15	All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.16	Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: <b>PC/ABS+15%TALC (FR40)</b>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.17	Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) <input type="checkbox"/> . TBBPA (reactive) <input type="checkbox"/> . Other; chemical name: _____, CAS #: _____  Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: <b>FR(40)</b>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.18	Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. 1. Chemical name: _____, CAS #: _____ 2. Chemical name: _____, CAS #: _____ 3. Chemical name: _____, CAS #: _____ Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4: <b>PC/ABS+15%TALC (FR40)</b>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.19	Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P7.20	Of total plastic parts' weight >25g, recycled material content is 0.0%.			
P7.21	Of total plastic parts' weight >25g, biobased material content is 0%.			
P7.22	Light sources are free from mercury If mercury is used specify: Number of lamps: _____ and max. mercury content per lamp: _____ mg	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P8 Batteries</b>				
P8.1*	Battery chemical composition: <b>lithium/manganese dioxide</b>			<input type="checkbox"/>
P8.2	Batteries meet the requirements of the following voluntary program/s:			<input checked="" type="checkbox"/>

Note B2: IEC61249-2-21 has maximum limits for chlorine and bromine but does not address fluorine, iodine and astatine which are included in the group of halogens.

Note B3: 'Starting from January 2009, Risk phrases can be replaced by Hazard phrases according to the Globally Harmonized System (GHS), mandatory by December 2010.



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Issue date *	5/5/2017	Logo	

**Product environmental attributes - Market requirements (continued)** Requirement met

Item Yes No n.a.

**P9 Energy consumption**

9.1 For the product the following power levels or energy consumptions are reported:

Energy mode *	Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference / Standard for energy modes and test method *	<input type="checkbox"/>
ENERGY STAR® On Mode * (System Short Idle)	8.64 W	8.53 W	8.62 W	ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
ENERGY STAR® On Mode * (System Long Idle)	4.28 W	4.27 W	4.30 W	ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
ENERGY STAR® Low Power Sleep Mode * (S3 - Windows "Standby") With Wake On LAN (WOL) Enabled	0.67 W	0.67 W	0.69 W	ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
ENERGY STAR® System Off/Apparent Off Mode * (ACPI S5) With Wake On LAN(WOL) Enabled (Test Unit connected to AC Mains, AC adapter connected to notebook)	0.31 W	0.31 W	0.34 W	ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
ETEC * Annual Energy Consumption (calculated value) for each input voltage	29.20 kWh/year	28.91 kWh/year	29.34 kWh/year	ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
Display resolution * : Megapixels					<input checked="" type="checkbox"/>
Print Speed * : Images per minute					<input checked="" type="checkbox"/>
Default time to enter energy save mode: minutes				ENERGY STAR® Program Requirements for Computers: Ver. 6.1	<input type="checkbox"/>
P9.2* Information about the energy save function is provided with the product.					<input checked="" type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>
P9.3* The product meets the energy requirements of the following voluntary program/s: ENERGY STAR® version: 6.1 Tier: Product category: <a href="#">Notebook PC</a> Others specify:					<input checked="" type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input checked="" type="checkbox"/>


**P10 Emissions**

**Noise emission – Declared according to ISO 9296**

P10.1 Mode	Mode description	Declared A-weighted sound power level $L_{WA,d}$ (B)	Declared A-weighted sound pressure level $L_{pA,m}$ (dB)		<input type="checkbox"/>
			Operator position <input checked="" type="checkbox"/> Desktop <input checked="" type="checkbox"/> or Desk side <input type="checkbox"/>	Bystander positions <input type="checkbox"/> (only if product is not operator attended)	
Idle	* Fans on, HDD spinning (if applicable)	* 1.6	16		<input type="checkbox"/>
Operation	* Fans on, HDD spinning	* 1.6	16		<input type="checkbox"/>
Other mode					<input type="checkbox"/>
Measured according to: <input checked="" type="checkbox"/> ISO7779 <input checked="" type="checkbox"/> ECMA-74 <input type="checkbox"/> Other (only if not covered by ECMA-74 with $L_{pA,m}$ measurement distance m)					

P10.2 The product meets the acoustic noise requirements of the following voluntary program/s:



Model number *	240 G6		
Issue date *	5/5/2017	Logo	

Product environmental attributes - Market requirements (continued)		Requirement met		
Item		Yes	No	n.a.
<b>Chemical emissions from printing products</b>				
P10.3*	Test performed according to ECMA-328 (ISO/IEC 28360) standard <input type="checkbox"/> , other specify:	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P10.4	Typical emission rate (print phase) is (mg/h): Dust      Ozone      Styrene      Benzene      TVOC			<input checked="" type="checkbox"/>
P10.5	Chemical emission requirements of the following voluntary program/s are met for : Dust <input type="checkbox"/> Ozone <input type="checkbox"/> Styrene <input type="checkbox"/> Benzene <input type="checkbox"/> TVOC <input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
<b>Electromagnetic emissions</b>				
P10.6	Computer display meets the requirement for low frequency electromagnetic fields of the following voluntary program/s:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P11 Consumable materials for printing products</b>				
P11.1*	A Safety Data Sheet (SDS) is available for the ink/toner preparation, even if not legally required (see P4.3).	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P11.2*	Paper containing post-consumer recycled fibers can be used, provided that it meets the requirements of EN12281.	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
P11.3*	2-sided (duplex) printing/copying is an integrated product function.	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
<b>P12 Ergonomics for computing products</b>				
P12.1*	The display meets the ergonomic requirements of ISO 9241-307 for visual display technologies.	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
P12.2*	The physical input device meets the requirements of ISO 9995 and ISO 9241-410.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
<b>P13 Packaging and documentation</b>				
P13.1*	Product packaging material type(s): <i>PAPER/Paperboard</i> weight (kg): <i>0.34</i> Product packaging material type(s): <i>PLASTIC/Polyethylene Expanded - EPE</i> weight (kg): <i>0.049</i> Product packaging material type(s): <i>PLASTIC/Polyethylene low density - LDPE</i> weight (kg): <i>0.0091</i>			
P13.2*	Product plastic packaging is free from PVC.	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
P13.3*	Specify media for user and product documentation (tick box): Electronic <input checked="" type="checkbox"/> , Paper <input type="checkbox"/> , Other <input type="checkbox"/>			<input type="checkbox"/>
P13.4*	For paper user and product documentation, please specify contained percentage of post-consumer recycled fiber: <i>0</i> %			<input type="checkbox"/>
Rev. P13.5	User and product documentation do not contain chlorine bleached paper	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>



P14	Additional information (See Note B4)																
All sections	1. Product environmental information contained in this declaration is valid as of the date the declaration is published. Changes to external standards referenced in the IT Eco-Declaration may invalidate some information contained in this declaration over time.																
P9	<p>1. Many PCs are offered in multiple configurations within the model family. Energy efficiency data listed in this declaration is for an ENERGY STAR® compliant configuration if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. For more information about HP's ENERGY STAR® qualified products, go to hp.com: <a href="http://www.hp.com/">http://www.hp.com/</a> and select the applicable market segments and product categories to find PC configurations that meet the ENERGY STAR® specifications.</p> <p>2. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.</p> <p>3. Energy Efficiency information published on the ECMA 370 The Eco Declaration represents a typically configured product base model meeting ENERGY STAR® specifications if offered within the model family. If optional components or modules are added, like extra hard disks or graphic cards etc, these can change the energy efficiency data listed above.</p> <p>4. Power consumption in the Off / Apparent Off mode is measured and reported with the network interface controller (NIC) WOL disabled.</p> <p>5. European Union Commission Regulation 1275/2008- Energy Efficiency Information:</p> <table border="1" data-bbox="277 698 1294 1034"> <thead> <tr> <th data-bbox="277 698 724 766">Mode / Condition</th> <th data-bbox="724 698 1018 766">Power Consumption in Watts at 230 VAC Input Voltage</th> <th data-bbox="1018 698 1294 766">Default Time to Mode / Condition (if applicable)</th> </tr> </thead> <tbody> <tr> <td data-bbox="277 766 724 811">Off Mode (if applicable)</td> <td data-bbox="724 766 1018 811"><b>0.28 W</b></td> <td data-bbox="1018 766 1294 811">Not Applicable</td> </tr> <tr> <td data-bbox="277 811 724 857">Standby Mode (if applicable)</td> <td data-bbox="724 811 1018 857">Not Applicable</td> <td data-bbox="1018 811 1294 857">Not Applicable</td> </tr> <tr> <td data-bbox="277 857 724 970">Network Standby / Sleep / Long Idle Mode if all wired network ports are connected and all wireless network ports are activated (if applicable)</td> <td data-bbox="724 857 1018 970"><b>0.87 W</b></td> <td data-bbox="1018 857 1294 970"><b>20 Min</b></td> </tr> <tr> <td data-bbox="277 970 724 1034">Network Standby / Sleep / Long Idle Mode (if applicable)</td> <td data-bbox="724 970 1018 1034"><b>0.725 W</b></td> <td data-bbox="1018 970 1294 1034"><b>20 Min</b></td> </tr> </tbody> </table> <p>6. European Union Commission Regulation 1275/2008- Wireless Network Instructions:</p> <p>Where applicable, activate and deactivate a wireless network using the instructions provided in the product user guide or the operating system. Information is also available at <a href="http://www.hp.com/support">www.hp.com/support</a>.</p>		Mode / Condition	Power Consumption in Watts at 230 VAC Input Voltage	Default Time to Mode / Condition (if applicable)	Off Mode (if applicable)	<b>0.28 W</b>	Not Applicable	Standby Mode (if applicable)	Not Applicable	Not Applicable	Network Standby / Sleep / Long Idle Mode if all wired network ports are connected and all wireless network ports are activated (if applicable)	<b>0.87 W</b>	<b>20 Min</b>	Network Standby / Sleep / Long Idle Mode (if applicable)	<b>0.725 W</b>	<b>20 Min</b>
Mode / Condition	Power Consumption in Watts at 230 VAC Input Voltage	Default Time to Mode / Condition (if applicable)															
Off Mode (if applicable)	<b>0.28 W</b>	Not Applicable															
Standby Mode (if applicable)	Not Applicable	Not Applicable															
Network Standby / Sleep / Long Idle Mode if all wired network ports are connected and all wireless network ports are activated (if applicable)	<b>0.87 W</b>	<b>20 Min</b>															
Network Standby / Sleep / Long Idle Mode (if applicable)	<b>0.725 W</b>	<b>20 Min</b>															
P10	1. Acoustic noise information published on the ECMA 370 The Eco Declaration represents a typically configured product base model only. If optional items with moving parts are added, like extra hard disks or graphic cards with fans etc, these can change acoustic noise values for which HP can take no responsibility.																

Note B4: Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.



## Legal references Europe Annex B

Reference	Declaration item
2002/95/EC (ROHS Directive)	P1.1, P4.1
REACH, Annex XVII	P1.6, P1.8, P4.2
REACH, Annex XVII	P1.4
REACH, Annex XVII	P1.2
REACH, Annex XVII	P1.7
REACH, Annex XVII	P1.9
Regulation (EC) No. 2037/2000, 2038/2000, 2039/2000	P1.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
2006/66/EC (Battery and accumulators Directive)	P2.1, P2.2, P2.3, P3.4, P8.1
2006/95/EC (Low Voltage Directive)	P3.1, 3.4
2004/108/EEC (New EMC Directive)	P3.2, 3.4
1999/5/EC (R&TTE Directive)	P3.3, 3.4
"REACH" Regulation (1907/2006), annex VII	P1.10
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P4.3
REACH article 31, annex II	P4.3
2004/12/EC (Directive on packaging and packaging waste)	P5.1
(97/129/EC) (Commission Decision on Identification System for Packaging Materials)	P5.2
2037/2000/EC Regulation on Substances that Deplete the Ozone Layer	P5.3
2002/96/EC (WEEE directive)	P3.4, P6.1
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P7.19



## Product Detail

### EPEAT Registry

Quick Search

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Company List

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## HP 240 G6 Notebook PC

Product:	HP 240 G6 Notebook PC
CAB:	Green Electronics Council CAB
Country:	Brazil
Product Type:	Notebooks
Manufacturer:	HP Inc.
URL:	<a href="http://www.hp.com">http://www.hp.com</a>
Rating:	
Registration Date:	5/8/2017
Monitor Type:	Flat Panel
Monitor Size:	21 in.
Product Status:	<input checked="" type="checkbox"/> Active
Exceptions:	Product is in conformance with EPEAT only when product is configured with an operating system (except FreeDOS and Linux) and high efficiency power supply certified to the ENERGY STAR specification.
Manufacturer Part #:	
UPC:	
EAN:	
Consumer or Institutional:	Not Indicated

#### Options:

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Criteria Category Summary	Optional Points
4.1 Reduction/elimination of environmentally sensitive materials	8/8
4.2 Materials selection	0/3
4.3 Design for end of life	5/5
4.4 Product longevity/life cycle extension	2/2
4.5 Energy conservation	1/2



4.6 End of life management	1/1
4.7 Corporate performance	2/2
4.8 Packaging	2/4
<b>Total Optional Points:</b>	<b>21/27</b>

**This Product is also registered in:**

Australia  
 Belgium  
 Canada  
 China  
 France  
 Germany  
 India  
 Mexico  
 New Zealand  
 Poland  
 Portugal  
 Spain  
 Sweden  
 Taiwan  
 United Kingdom  
 United States

About EPEAT

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 Careers

Participants

Partners  
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 Clarifications and Interpretations  
 Recycling

My Account

Manage Account  
 Login



Experiencing issues with it  
 Email

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Use of company Logo/  
 not imply en





**Hewlett Packard  
Enterprise**

## China RoHS 2

Management Methods for Restricted Use of Hazardous Substances in Electrical and Electronic Products, otherwise known as China RoHS 2, is a regulation that came into effect on July 1, 2016. China RoHS 2 consists of two phases.

### **Phase I:** Labeling requirements

All Electrical and Electronic Products (EEP) must be properly labeled according to the China RoHS standards. Phase I is effective July 1, 2016.

### **Phase II:** Catalog requirements

EEP listed in the China RoHS 2 catalog (which will be a list of specific products or product categories) must comply with China's substance restrictions as defined in China's maximum concentration value (MCV) requirements. The implementation dates for Phase II are still to be determined.

### **Hewlett Packard Enterprise's compliance**

HPE is committed to comply with all applicable laws and regulations including RoHS like legislation. As of July 1, 2016, HPE met the Phase I labeling requirements of China's Management Methods for Restricted Use of Hazardous Substances in Electrical and Electronic Products, otherwise known as China RoHS 2. HPE has also met the requirements of the several other [RoHS legislations](#) currently in effect.

As a part of the China RoHS 2 Phase I labeling requirements, HPE provides the following hazardous substances tables for our products.

### **Hazardous substances table**

[Enterprise servers, storage products, spare parts and networking \(unless otherwise indicated\)](#)

### **Frequently asked questions (FAQs)**

#### **What HPE products are covered by China RoHS 2 labeling requirements?**

China's definition of EEP is very broad, ranging from whole products to components/parts to materials. It also covers a vast range of product categories, from electronic radar products, electronic communication products, broadcasting and television products, computer products, household electronic appliances, electronic surveying instruments, to specialized electronic products. HPE's products are covered by China RoHS 2 labeling requirements.

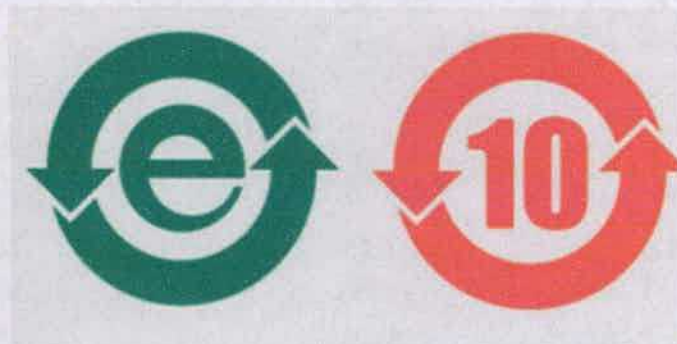




## Environmental documentation

### Where will the “EEP Pollution Control Mark” be displayed on HPE branded products?

Typically you will find the EEP Pollution Control Mark located with the other regulatory/agency labels on the product.



### Which HPE products carry the “e” logo and which products carry the “EPUP” logo?

For purposes of China RoHS 2 labeling, the majority of HPE brand products will carry the “EPUP” logo. This is because China does not recognize the EU RoHS material application exemptions for purposes of labeling.

### Why does my service part have a different EPUP code than that of my product?

To effectively and consistently manage the requirements to meet the China RoHS 2 Legislation, HPE spare parts sold in the People's Republic of China (in support of HPE Products), will take a standardized and conservative approach. As a result, the spare part documentation may state a shorter EPUP than that stated on the product or in the China RoHS 2 user documentation that accompanied the product.



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a0003858BENW, December 2017



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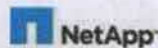


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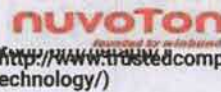


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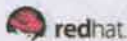


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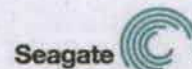
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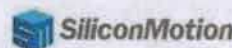
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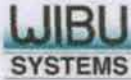




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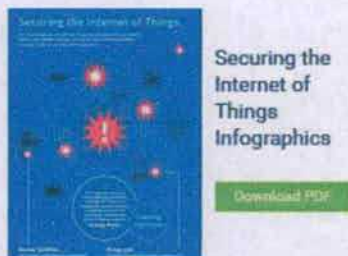
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## Ubuntu on HP HP 14 Laptop PC/HP 240 G6 Notebook PC/HP 246 G6 Notebook PC

### Feedback

If there is an issue with the information for this system, please [let us know](#).

The HP HP 14 Laptop PC/HP 240 G6 Notebook PC/HP 246 G6 Notebook PC laptop with the components described below has been awarded the status of certified pre-install for Ubuntu.

Please note that for pre-installed systems:

1. The system is available in some regions with a special image of Ubuntu pre-installed by the manufacturer. It takes advantage of the hardware features for this system and may include additional software. You should check when buying the system whether this is an option.
2. Standard images of Ubuntu may not work at all on the system or may not work well, though Canonical and computer manufacturers will try to certify the system with future standard releases of Ubuntu.

### Ubuntu 16.04 LTS 64-bit

Pre-installed by manufacturer

### Testing details

This system was tested with 16.04 LTS, running the 4.4.0-67-generic kernel.

### Certification notes

#### MMC Cards

The card reader does not work with MMC cards. SD and SDHC cards, however, should work as expected.

#### Hibernate

Hibernate is disabled on this system

#### BIOS

Insyde: B.13 (UEFI)

### Hardware summary

This system was tested with these key components:

**Processor** Intel Intel(R) Pentium(R) CPU N3710 @ 1.60GHz



**video** Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Integrated Graphics Controller

**Ethernet** Realtek Semiconductor Co., Ltd. RTL8111/8168/8411 PCI Express Gigabit Ethernet Controller

**Wireless** Realtek Semiconductor Co., Ltd. 10ec:d723

## Hardware details

**Audio** Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Series High Definition Audio Controller

Intel Unknown

**BIOS** Insyde B.13

**Bluetooth** Realtek Semiconductor Co., Ltd. 0bda:b009

**Board** HP 8320

**Capture** Cheng Uei Precision Industry Co., Ltd (Foxlink) HP TrueVision HD Camera

**Cdrom** Aquantia Corp. hp DVDRW DA8AESH

**Chassis** HP Notebook

**Disk** Aquantia Corp. ST1000LM024 HN-M101MBB

**Efi** Insyde EFI v2.40

**Keyboard** Aquantia Corp. AT Translated Set 2 keyboard

**Mouse** Lenovo 17ef:6045

**Network** Realtek Semiconductor Co., Ltd. RTL8111/8168/8411 PCI Express Gigabit Ethernet Controller

**Processor** Intel Intel(R) Pentium(R) CPU N3710 @ 1.60GHz



<b>System</b>	HP HP Laptop 14-bs0xx
<b>Touchpad</b>	Aquantia Corp. ETPS/2 Elantech Touchpad
<b>Usb</b>	Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Series USB xHCI Controller
<b>Video</b>	Intel Atom/Celeron/Pentium Processor x5-E8000/J3xxx/N3xxx Integrated Graphics Controller
<b>Wireless</b>	Realtek Semiconductor Co., Ltd. 10ec:d723
<b>Other</b>	Aquantia Corp. HDA Intel PCH HDMI/DP,pcm=3 Aquantia Corp. HDA Intel PCH Headphone Aquantia Corp. HDA Intel PCH Mic Aquantia Corp. HP WMI hotkeys Aquantia Corp. HP Wireless hotkeys Aquantia Corp. Lid Switch Aquantia Corp. Power Button Aquantia Corp. Video Bus Genesys Logic, Inc USB-2.0 4-Port HUB Linux Foundation 2.0 root hub Linux Foundation 3.0 root hub

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Nome Fantasia:	FLEXTRONICS TECNOLOGIA
Razão Social:	FLEXTRONICS INTERNATIONAL TECNOLOGIA LTDA
CNPJ:	74.404.229/0005-51
Endereço:	Av. Liberdade, 6315 Iporanga Sorocaba / SP - 18087170
Contato:	Jorge Funaro jorge.funaro@flextronics.com (15) 4009-6330 www.flextronics.com
Produto:	Impressora a laser, policromática com velocidade de impressão superior a 45 ppm
Processo MCT/Data:	01200.004893/2014-82 de 27/10/2014
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	72, de 13/02/2015 DOU 18/02/2015 ()
Modelos:	(16-04-15: C792DE) (16-04-15: C950DE) (26-01-18: LEXMARK CS923DE)
Produto:	Impressora laser monocromática, com velocidade de impressão inferior a 30 páginas por minuto, combinada com unidade de digitalização de informações
Processo MCT/Data:	01200.006655/2005-11 de 22/11/2005
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	584, de 31/08/2006 DOU 04/09/2006 ()
Modelos:	Q6504A; Q6510A; CB376A.(15-08-08: KIWI - CC431A )(15-08-08: KIWI - CC430A)(22-10-10: HP LASERJET M1536DNF MFP MONO PRINTER) (22-10-10: HP LASERJET M1212NF MFP MONO PRINTER) (22-10-10: HP LASERJET M1132 MFP MONO PRINTER) (11-03-13: HP LASERJET PRO MFP M127FW) (11-03-13: HP LASERJET PRO MFP M125NW) (11-03-13: HP LASERJET PRO MFP M125A) (11-03-13: HP LASERJET PRO MFP M127FN)(09-09-13: HP LASERJET PRO 100 MFP M127FN) (09-09-13: HP LASERJET PRO MFP 100 M125A) (16-03-14: HP LASERJET PRO MFP M225DW)
Produto:	Impressora multifuncional a laser, monocromática, com velocidade de impressão superior a 45 ppm
Processo MCT/Data:	01200.002836/2015-40 de 21/07/2015
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	1107, de 10/12/2015 DOU 11/12/2015 ( <a href="http://pesquisa.in.gov.br/imprensa/jsp/visualiza/index.jsp?jornal=1&amp;pagina=3&amp;data=11/12/2015">http://pesquisa.in.gov.br/imprensa/jsp/visualiza/index.jsp?jornal=1&amp;pagina=3&amp;data=11/12/2015</a> )
Modelos:	(23-12-15: HP LASERJET ENTERPRISE MFP M630DN) (23-12-15: HP LASERJET ENTERPRISE MFP M630F) (23-12-15: HP LASERJET ENTERPRISE FLOW MFP M630Z) (23-12-15: HP LASERJET MANAGED MFP M630HM) (23-12-15: HP LASERJET MANAGED FLOW MFP M630ZM) (23-12-15: HP LASERJET ENTERPRISE MFP M630H) (30-06-17: SL-M5360RX) (30-06-17: SL-M5370LX)
Produto:	Impressora multifuncional a laser, policromática com velocidade de impressão superior a 45 ppm
Processo MCT/Data:	01200.004893/2014-82 de 27/10/2014
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	72, de 13/02/2015 DOU 18/02/2015 ()
Modelos:	(16-04-15: X792DE) (16-04-15: X954DHE) (25-01-16: C5725DHE) (25-01-16: CX725DHE) (25-01-16: CX820DE) (25-01-16: CX825DE) (25-01-16: CX860DE) (26-01-18: LEXMARK CX923DTE)



Produto:	Impressora multifuncional a laser, policromática, com velocidade inferior ou igual a 45 ppm, com funções de cópia, impressão e digitalização
Processo MCT/Data:	01200.001738/2012-42 de 31/05/2012
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	535, de 14/06/2013 DOU 17/06/2013 ()
Modelos:	(02-07-13: HP LASERJET PRO200 COLOR MFP M276NW) (02-07-13: HP LASERJET PRO100 COLOR MFP M175NW) (02-07-13: HP LASERJET PRO100 COLOR MFP M175A) (26-08-13: HP LASERJET PRO COLOR MFP M176N) (26-08-13: HP LASERJET PRO COLOR MFP M177FW) (14-03-14: HP LASERJET PRO MFP M225DW) (05-11-14: CX510DHE) (07-11-14: X748DE) (07-11-14: CX310DN) (07-11-14: CX410DE) (07-11-14: X925DE) (07-11-14: X952DTE) (07-11-14: X950DE) (06-07-15: HP COLOR LASERJET MANAGED MFP M577CM) (06-07-15: HP COLOR LASERJET ENTERPRISE MFP M577DN) (06-07-15: HP COLOR LASERJET ENTERPRISE MFP M577F) (06-07-15: HP COLOR LASERJET ENTERPRISE MFP M577Z) (06-07-15: HP COLOR LASERJET MANAGED MFP M577DNM) (06-07-15: HP COLOR LASERJET MANAGED MFP M577ZM) (09-06-17: HP COLOR LASERJET PRO MFP M180NW) (30-05-17: CLX-6260FR) (26-01-18: LEXMARK CX921DE) (26-01-18: LEXMARK CX922DE) (06-04-18: LEXMARK CX310DN)
Produto:	Impressora térmica, de impressão termo-direta
Processo MCT/Data:	01200.003556/2008-20 de 17/09/2008
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	375, de 28/05/2009 DOU 29/05/2009 ()
Modelos:	IBM 4610 ? TI4; IBM 4610 ? kn4
Produto:	Microcomputador portátil, de peso inferior a 3,5kg, com teclado alfanumérico de no mínimo 70 teclas e com uma tela de área superior a 140cm2 e inferior a 560cm2
Processo MCT/Data:	01200.004083/2007-05 de 02/08/2007
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	157, de 25/03/2008 DOU 27/03/2008 ()
Modelos:	FLXN502; (06-05-10: FLXN500) (06-05-10: MICROCOMPUTADOR PORTÁTIL THINKPAD X201) (20-10-10: HP MINI 110-3110BR BRZL) (20-10-10: FLXN500) (20-10-10: FLXN500(20-10-10: HP MINI 110-3115BR BRZL) (20-10-10: HP MINI 110-3120BR BRZL) (20-10-10: HP MINI 110-3130BR BRZL) (20-10-10: HP MINI 110-3150BR BRZL) (24-06-11: FLXN500 ) (24-06-11: FLXN500) (24-06-11: HP PAVILION DM1-3250BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3255BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3250BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3260BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3270BR NB PC BRZL) (15-07-11: FLXN500) (15-07-11: MICROCOMPUTADOR PORTÁTIL THINKPAD X220) (28-10-11: FLXN500) (28-10-11: HP PAVILION DM1-3251BR NB PC BRZL) (24-05-12: FLXN500) (24-05-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T430) (24-05-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T430J) (11-06-12: FLXN500) (11-06-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T420) (11-06-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T420J) (11-07-12: FLXN500) (11-07-12: MICROCOMPUTADOR PORTÁTIL THINKPAD X230) (11-03-13: ASPIRE V5-471) (11-03-13: FLXN500) (20-03-13: ASPIRE V5-431) (20-03-13: ASPIRE V5-431) (20-03-13: FLXN500) (23-09-13: FLXN500) (23-09-13: HP PAVILION 14 NOTEBOOK PC) (23-10-13: HP PROBOOK 6470B NOTEBOOK PC) (23-10-13: FLXN500) (23-10-13: HP ELITEBOOK 8470P NOTEBOOK PC) (23-10-13: HP PROBOOK 440 G1 NOTEBOOK PC) (23-10-13: HP PROBOOK 6470B NOTEBOOK PC) (31-10-13: FLXN500) (31-10-13: HP PAVILION 14-N010BR NB PC BRZL) (31-10-13: HP PAVILION 14-N020BR NB PC BRZL) (31-10-13: HP PAVILION 14-N030BR NB PC BRZL) (31-10-13: HP PAVILION 14-N040BR NB PC BRZL) (31-10-13: HP PAVILION 14-N050BR NB PC BRZL) (31-10-13: HP PAVILION 14-N050BR NB PC BRZL) (22-11-13: FLXN500) (22-11-13: HP 14-D028BR NB PC BRZL) (22-11-13: HP 14-D030BR NB PC BRZL) (22-11-13: HP 14-D030BR NB PC BRZL) (22-11-13: HP PAVILION 14-N060BR NB PC BRZL) (22-11-13: HP PAVILION 14-N070BR NB PC BRZL) (17-12-13: FLXN500) (17-12-13: HP PAV TS 14-N060BR ULTRABOOK BRZL) (17-12-13: HP PAV TS 14-N070BR ULTRABOOK BRZL) (18-12-13: FLXN500) (18-12-13: H240G2U33110MQX500NXNC04PA BRZL) (30-12-13: FLXN500) (30-12-13: HP 240 G2 NOTEBOOK PC) (30-12-13: HP 240 G2 NOTEBOOK PC) (30-12-13: HP EL ITEBOOK 840 G1 NOTEBOOK PC) (30-12-13: HP ELITEBOOK 840 G1 NOTEBOOK PC) (30-12-13: HP PROBOOK 640 G1 NOTEBOOK PC) (30-12-13: HP PROBOOK 645 G1 NOTEBOOK PC) (30-12-13: HP ZBOOK 14 MOBILE WORKSTATION) (19-02-14: FLXN500) (19-02-14: HP 14-D026BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D027BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D029BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D029BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D031BR NOTEBOOK PC BRZL) (13-05-14: HP PAVILION 11-N021BR X360 PC BRZL) (13-05-14: HP PAVILION 11-N022BR X360 PC BRZL) (05-06-14: HP 14-R050BR NOTEBOOK PC BRZL) (05-06-14: HP 14-R051BR NOTEBOOK PC BRZL) (05-06-14: HP 14-R052BR NOTEBOOK PC BRZL) (25-06-14: FLXN500) (01-07-14: FLXN500) (03-07-14: FLXN500) (22-10-15: HP NOTEBOOK 14-AC101BR BRZL) (22-10-15: HP NOTEBOOK 14-AC108BR BRZL) (22-10-15: HP NOTEBOOK 14-AC105BR BRZL) (22-10-15: HP NOTEBOOK 14-AC111BR BRZL) (22-10-15: HP NOTEBOOK 14-AC141BR BRZL) (22-10-15: HP NOTEBOOK 14-AC121BR BRZL) (12-11-15: HP 240 G4 NOTEBOOK PC) (13-07-16: COMPAQ PRESARIO CQ-21) (27-09-16: COMPAQ PRESARIO CQ-23 4GB S5D32 NO ODD WINDOWS 10 EN) (27-09-16: COMPAQ PRESARIO CQ-23 4GB HD500 NO ODD WINDOWS 10 VN) (27-07-17: HP 240 G6 NOTEBOOK PC) (27-07-17: HP 246 G6 NOTEBOOK PC) (04-08-17: HP ELITEBOOK 840 G4 NOTEBOOK PC) (18-08-17: COMPAQ PRESARIO CQ-17)



Produto:	Microcomputador portátil, de peso inferior a 3,5kg, com teclado alfanumérico de no mínimo 70 teclas e com uma tela de área superior a 140cm2 e inferior a 560cm2 (Port. 131)
Processo MCT/Data:	01200.001476/2007-59 de 04/04/2007
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	131, de 14/03/2008 DOU 17/03/2008 ()
Modelos:	FLXN500; (24-06-11: HP PAVILION DM1-3250BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3270BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3255BR NB PC BRZL) (24-06-11: HP PAVILION DM1-3260BR NB PC BRZL) (11-03-13: ASPIRE V5-471) (20-03-13: ASPIRE V5-431) (23-09-13: HP PAVILION 14 NOTEBOOK PC) (23-10-13: HP PROBOOK 440 G1 NOTEBOOK PC) (23-10-13: HP PROBOOK 6470B NOTEBOOK PC) (23-10-13: HP ELITEBOOK 8470P NOTEBOOK PC) (31-10-13: HP PAVILION 14-N010BR NB PC BRZL) (31-10-13: HP PAVILION 14-N020BR NB PC BRZL) (31-10-13: HP PAVILION 14-N030BR NB PC BRZL) (31-10-13: HP PAVILION 14-N040BR NB PC BRZL) (31-10-13: HP PAVILION 14-N050BR NB PC BRZL) (22-11-13: HP 14-D028BR NB PC BRZL) (22-11-13: HP 14-D030BR NB PC BRZL) (22-11-13: HP PAVILION 14-N060BR NB PC BRZL) (22-11-13: HP PAVILION 14-N070BR NB PC BRZL) (17-12-13: HP PAV TS 14-N060BR ULTRABOOK BRZL) (17-12-13: HP PAV TS 14-N070BR ULTRABOOK BRZL) (18-12-13: H240G2U33110MQX500XNXC04PA BRZL) (30-12-13: HP 240 G2 NOTEBOOK PC) (30-12-13: HP PROBOOK 640 G1 NOTEBOOK PC) (30-12-13: HP PROBOOK 645 G1 NOTEBOOK PC) (30-12-13: HP ELITEBOOK 840 G1 NOTEBOOK PC) (30-12-13: HP ZBOOK 14 MOBILE WORKSTATION) (19-02-14: HP 14-D026BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D027BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D029BR NOTEBOOK PC BRZL) (19-02-14: HP 14-D031BR NOTEBOOK PC BRZL) (13-05-14: HP PAVILION 11-N021BR X360 PC BRZL) (13-05-14: HP PAVILION 11-N022BR X360 PC BRZL) (05-06-14: HP 14-R050BR NOTEBOOK PC BRZL) (05-06-14: HP 14-R051BR NOTEBOOK PC BRZL) (05-06-14: HP 14-R052BR NOTEBOOK PC BRZL) (03-07-14: HP PROBOOK 440 G2 NOTEBOOK PC) (25-06-14: HP PAVILION 14-V060BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V061BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V062BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V063BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V064BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V065BR NOTEBOOK PC BRZL) (25-06-14: HP PAVILION 14-V066BR NOTEBOOK PC BRZL) (01-07-14: HP 240 G3 NOTEBOOK PC) (13-10-14: HP ELITEBOOK 745 G2 NOTEBOOK PC) (13-10-14: HP ELITEBOOK 740 G1 NOTEBOOK PC) (28-08-14: HP PAVILION 11-N025BR X360 PC BRZL) (28-08-14: HP PAVILION 11-N026BR X360 PC BRZL) (24-12-14: HP PAVILION 11-N127BR X360 PC BRZL) (08-01-15: HP ELITEBOOK 840 G2 NOTEBOOK PC) (29-01-15: COMPAQ PRESARIO CQ-23 2GB WINDOWS) (29-01-15: COMPAQ PRESARIO CQ-23 4GB WINDOWS) (29-01-15: COMPAQ PRESARIO CQ-23 2GB LINUX) (22-07-15: COMPAQ PRESARIO CQ-23 2GB WINDOWS 10 EN) (22-07-15: COMPAQ PRESARIO CQ-23 2GB WINDOWS 10 VN) (22-07-15: COMPAQ PRESARIO CQ-23 4GB WINDOWS 10 SL) (14-09-15: HP NOTEBOOK 14-AC102BR BRZL) (14-09-15: HP NOTEBOOK 14-AC139BR BRZL) (14-09-15: HP NOTEBOOK 14-AC140BR BRZL) (01-10-15: COMPAQ PRESARIO CQ-23 4GB LINUX) (13-10-15: HP PAVILION 14-V067BR NOTEBOOK PC BRZL) (22-10-15: HP NOTEBOOK 14-AC108BR BRZL) (22-10-15: HP NOTEBOOK 14-AC105BR BRZL) (22-10-15: HP NOTEBOOK 14-AC111BR BRZL) (22-10-15: HP NOTEBOOK 14-AC141BR BRZL) (22-10-15: HP NOTEBOOK 14-AC121BR BRZL) (12-11-15: HP PAV X360 CONVERT 13-S101BR BRZL) (12-11-15: HP PAV X360 CONVERT 13-S103BR BRZL) (12-11-15: HP PAV X360 CONVERT 13-S104BR BRZL) (27-11-15: HP PROBOOK 440 G3 NOTEBOOK PC) (27-11-15: HP PROBOOK 440 G3 NOTEBOOK PC) (09-12-15: HP PAVILION 11-N225BR X360 PC BRZL) (09-12-15: HP PAVILION 11-N226BR X360 PC BRZL) (23-12-15: HP NOTEBOOK 14-AP020 BRZL) (23-12-15: HP NOTEBOOK 14-AP010 BRZL) (23-12-15: HP ELITEBOOK 745 G3 NOTEBOOK PC) (18-02-16: HP ELITEBOOK 840 G3 NOTEBOOK PC) (18-03-16: HP PROBOOK 640 G2 NOTEBOOK PC) (17-06-16: COMPAQ PRESARIO CQ-23 2GB WINDOWS 10 EN) (17-06-16: COMPAQ PRESARIO CQ-23 2GB WINDOWS 10 VN) (17-06-16: COMPAQ PRESARIO CQ-23 4GB LINUX) (17-06-16: COMPAQ PRESARIO CQ-23 4GB WINDOWS 10 SL) (24-08-16: COMPAQ PRESARIO CQ-360) (16-09-16: HP 240 G5 NOTEBOOK PC) (07-12-16: HP 246 G5 NOTEBOOK PC) (25-09-17: COMPAQ PRESARIO CQ-23 4GB HD500 NO ODD WINDOWS 10) (25-09-17: COMPAQ PRESARIO CQ-23 2GB WINDOWS 10) (03-11-17: HP PROBOOK 440 G5 NOTEBOOK PC) (27-04-18: HP 240 G6 NOTEBOOK PC) (27-04-18: HP 246 G6 NOTEBOOK PC) (19-06-18: HP PROBOOK 640 G4 NOTEBOOK PC) (31-07-18: HP ELITEBOOK 840R G4 NOTEBOOK PC) (31-07-18: HP PROBOOK 645 G4 NOTEBOOK PC) (17-08-18: COMPAQ PRESARIO CQ-15) (08-02-19: HP 246 G7 NOTEBOOK PC) (08-02-19: HP 240 G7 NOTEBOOK PC)
Produto:	Microcomputador portátil, de peso inferior a 3,5kg, com teclado alfanumérico de no mínimo 70 teclas e com uma tela de área superior a 560 cm2
Processo MCT/Data:	01200.001475/2007-12 de 04/04/2007
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	888, de 01/12/2008 DOU 03/12/2008 ()
Modelos:	LENOVO 3000 N200(05-01-09: MICROCOMPUTADOR PORTÁTIL THINKPAD R61) (05-01-09: T400)(30-03-10: MICROCOMPUTADOR PORTÁTIL THINKPAD T410) (22-09-10: HP MINI 110-3115BR BRZL) (22-09-10: HP MINI 110-3130BR BRZL) (22-09-10: HP MINI 110-3150BR BRZL) (22-09-10: HP MINI 110-3150BR BRZL) (15-10-10: HP MINI 110-3120BR BRZL) (21-02-11: MICROCOMPUTADOR PORTÁTIL THINKPAD T420) (16-06-11: MICROCOMPUTADOR PORTÁTIL THINKPAD T420I) (30-04-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T430I) (30-04-12: MICROCOMPUTADOR PORTÁTIL THINKPAD T430) (14-10-13: ASPIRE E1-522)
Produto:	Microcomputador portátil, de peso superior a 3,5kg, com teclado alfanumérico de no mínimo 70 teclas e com uma tela de área superior a 140cm2 e inferior a 560cm2
Processo MCT/Data:	01200.004083/2007-05 de 02/08/2007
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	157, de 25/03/2008 DOU 27/03/2008 ()
Modelos:	FLXNS03,(23-06-08: THINKPAD R61I) (23-06-08: THINKPAD R61E) (23-06-08: THINKPAD T61) (09-09-08: MICROCOMPUTADOR PORTÁTIL THINKPAD SL500) (09-09-08: MICROCOMPUTADOR PORTÁTIL THINKPAD SL400) (02-10-08: MICROCOMPUTADOR PORTÁTIL THINKPAD X200) (06-05-11: MICROCOMPUTADOR PORTÁTIL THINKPAD EDGE E420)



Produto:	Microcomputador portátil, sem teclado, com tela sensível ao toque ("touch screen") de peso inferior a 750g (Tablet PC)
Processo MCT/Data:	01200.001588/2011-96 de 10/06/2011
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	634, de 06/09/2012 DOU 10/09/2012 ()
Modelos:	(28-05-14: HP 7.1 1201 TABLET BRZL) (28-05-14: HP 8 1401 TABLET BRZL) (01-07-14: B1-730) (30-06-15: HP PRO X2 612 G1) (30-06-15: HP PRO X2 612 G1 )
Produto:	Modulador/demodulador ("modem")
Processo MCT/Data:	01200.004989/2012-89 de 18/12/2012
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	992, de 24/09/2013 DOU 25/09/2013 ()
Modelos:	
Produto:	Módulo de comunicação satelital para aplicação em rastreamento via GPS
Processo MCT/Data:	01200.001852/2005-42 de 28/04/2005
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	396, de 26/06/2006 DOU 27/06/2006 ()
Modelos:	M2
Produto:	Módulo de conversão de sinais digitais e de rádio-frequência (RF) para estação rádio-base de telefonia celular
Processo MCT/Data:	01200.003913/2009-31 de 27/10/2009
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	778, de 24/09/2010 DOU 27/09/2010 ()
Modelos:	GM5M4DRFU
Produto:	Rádio modem
Processo MCT/Data:	01200.005185/2007-30 de 24/09/2007
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	103, de 26/02/2009 DOU 27/02/2009 ()
Modelos:	TM502A/CCE; TM504G/CE
Produto:	Rádio-modem para tecnologia celular
Processo MCT/Data:	01200.001219/2009-89 de 14/05/2009
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	930, de 28/10/2009 DOU 29/10/2009 ()
Modelos:	LEON-G100.(19-12-12: FRHA ? MÓDULO RADIO TRANSCPTOR PARA ESTAÇÃO RADIO-BASE DE TECNOLOGIA CELULAR MULTIMODO)
Produto:	Roteador digital para rede com fio
Processo MCT/Data:	01200.001307/2016-18 de 26/04/2016
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	4572, de 20/10/2016 DOU 24/10/2016 ( <a href="http://pesquisa.in.gov.br/imprensa/jsp/visualiza/index.jsp?jornal=1&amp;pagina=3&amp;data=24/10/2016">http://pesquisa.in.gov.br/imprensa/jsp/visualiza/index.jsp?jornal=1&amp;pagina=3&amp;data=24/10/2016</a> )
Modelos:	{11-11-16: CISCO ISR4321} {11-11-16: CISCO ISR4331} {11-11-16: ISR4321/K9} {11-11-16: ISR4321-V/K9} {11-11-16: ISR4331/K9} {11-11-16: ISR4331-V/K9} {04-01-17: CISCO 2911} {04-01-17: CISCO 1905} {14-01-19: C841M-4X/K9} {14-01-19: C841M-8X/K9} {08-02-19: ASR-9910} {08-02-19: ASR-9010-SYS} {25-02-19: ASR-9010} {29-03-19: ASR-9006} {29-03-19: ASR-9904} {29-03-19: ASR-9922} {29-03-19: ASR1004} {29-03-19: ASR1006} {29-03-19: ASR1013} {29-03-19: ASR1009} {04-04-19: ASR-9906}



Produto:	Roteador digital para rede sem fio
Processo MCT/Data:	01200.000145/2012-69 de 19/01/2012
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	719, de 04/10/2012 DOU 09/10/2012 ()
Modelos:	(19-11-12: CISCO 1905) (19-11-12: CISCO 2911)(28-09-15: CISCO ISR4321) (28-09-15: CISCO ISR4331) (28-09-15: ISR4321/K9) (28-09-15: ISR4321-V/K9) (28-09-15: ISR4331/K9) (14-01-19: C841M-4X/K9) (14-01-19: C841M-8X/K9)
Produto:	Teclado para distribuidor (dispensador) automático de papel-moeda
Processo MCT/Data:	01200.001609/2009-59 de 08/06/2009
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	988, de 18/11/2009 DOU 20/11/2009 ()
Modelos:	NCR-445-0717238 (português); NCR-445-0717118 (espanhol).
Produto:	Terminal para pagamento eletrônico por meio de cartão de crédito ou débito
Processo MCT/Data:	01200.006146/2002-45 de 04/11/2002
CNPJ da Incentivada:	74404229000551
Portaria MCT/MDIC/MF:	113, de 24/03/2003 DOU 26/03/2003 ()
Modelos:	N575C; T7P; T7PLUS; S7S; MAGIC 5100; OMIRO X; I 5100; FLXPOS01; FLXPOS02; FLXPOS03; FLXPOS04; MAGIC1800(15-10-10: VX 810 ) (15-10-10: VX 670 GPRS) (15-10-10: VX 810 GPRS) (15-10-10: VX 520 ) (15-10-10: VX 520 GPRS) (15-10-10: VX 670) (15-10-10: VX 680 GPRS) (27-05-11: VX680 GPRS CTLS) (17-02-12: VX520 CTLS) (17-02-12: VX820 CTLS)(12-08-14: VX685 GPRS CTLS AZUL) (12-08-14: VX685 GPRS CTLS CINZA)(24-12-14: VX685 GPRS CTLS) (24-12-14: VX685 GPRS CTLS CIELO) (24-12-14: VX685 GPRS CTLS REDE) (07-07-15: VX520 CTLS COLOR) (12-11-15: E105) (23-12-15: E265 GPRS) (14-03-16: VX690 CTLS 3G WIFI/BT) (14-03-16: VX690 CTLS 3G WIFI/BT CIELO) (14-03-16: VX690 CTLS 3G WIFI/BT REDE) (14-03-16: VX690 CTLS 3G WIFI/BT GETNET) (10-08-16: E275 GPRS WIFI/BT) (10-08-16: E275 GPRS WIFI/BT UOL) (10-08-16: P200 CTLS) (10-08-16: P200 CTLS CIELO) (10-08-16: P400 CTLS) (10-08-16: P400 CTLS CIELO) (10-08-16: V200C CTLS D/E) (10-08-16: V200C CTLS D/E CIELO) (07-10-16: E265 GPRS) (07-10-16: E265 GPRS GETNET) (03-03-17: V200C CTLS) (03-03-17: V200C CTLS CIELO) (03-03-17: V200C CTLS REDE) (03-03-17: V200C CTLS GETNET) (03-03-17: P200 CTLS REDE) (03-03-17: P200 CTLS GETNET) (03-03-17: C680 CTLS 3G/WIFI/BT) (03-03-17: C680 CTLS 3G/WIFI/BT CIELO) (03-03-17: C680 CTLS 3G/WIFI/BT REDE) (03-03-17: C680 CTLS 3G/WIFI/BT GETNET) (03-03-17: VX685 CTLS GPRS GETNET) (11-12-17: V205C CTLS) (11-12-17: V205C CTLS CIELO) (11-12-17: V205C CTLS REDE) (11-12-17: V205C CTLS GETNET) (11-12-17: V240M 3G/WIFI/BT) (11-12-17: V240M 3G/WIFI/BT CIELO) (11-12-17: V240M 3G/WIFI/BT REDE) (11-12-17: V240M 3G/WIFI/BT GETNET) (02-05-19: X990 4G/BT/WI-FI) (02-05-19: X990 4G/BT/WI-FI CIELO) (02-05-19: X990 4G/BT/WI-FI GETNET) (02-05-19: X990 4G/BT/WI-FI REDE)

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empresas=FLEXTRONIC&cnj=...

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Voltar





Ministério do Meio Ambiente  
Instituto Brasileiro do Meio Ambiente e dos Recursos Naturais Renováveis



CADASTRO TÉCNICO FEDERAL  
CONSULTA PÚBLICA A CERTIFICADO DE REGULARIDADE - CR

Registro n.º: 439710 Data da consulta: 15/05/2019 CR emitido em: 14/05/2019 CR válido até: 14/08/2019

Dados básicos

CNPJ: 61.797.924/0009-02  
Razão social: HEWLETT PACKARD BRASIL LTDA  
Nome fantasia: HEWLETT PACKARD BRASIL LTDA  
Data de abertura: 01/02/2003

Endereço

Logradouro: ESTRADA DA CRUZ GRANDE Complemento: GALPÃO 6 - SETOR 6  
N.º: 1000 Município: LOUVEIRA  
Bairro: SANTO ANTÔNIO UF: SP  
CEP: 13290-000

Cadastro Técnico Federal de Atividades Potencialmente Poluidoras e Utilizadoras de Recursos Ambientais – CTF/APP

Categoria	Detalhe
5 - Indústria de material Elétrico, Eletrônico e Comunicações	2 - Fabricação de material elétrico, eletrônico e equipamentos para telecomunicação e informática
18 - Transporte, Terminais, Depósitos e Comércio	81 - Comércio de produtos químicos e produtos perigosos - Resolução CONAMA nº 401/2008 (importação, pilhas, baterias)

Conforme dados disponíveis na presente data, a pessoa jurídica acima possui Certificado de Regularidade em conformidade com as obrigações cadastrais e de prestação de informações ambientais sobre as atividades desenvolvidas sob controle e fiscalização do Ibama, por meio do CTF/APP.

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O Certificado de Regularidade do CTF/APP não habilita o transporte e produtos e subprodutos florestais e faunísticos.

Fechar





# Certificate of Registration

QUALITY MANAGEMENT SYSTEM - ISO 9001:2015

This is to certify that:

HP Inc.  
11445 Compaq Center Drive, Bldg. CCM03  
Houston  
Texas  
77070  
USA

Holds Certificate No:

**FM 639901**

and operates a Quality Management System which complies with the requirements of ISO 9001:2015 for the following scope:

Design, development, marketing, procurement, sales order fulfillment, supply chain management, and support of printers, personal computers, mobile devices, and accessories.

For and on behalf of BSI:

  
\_\_\_\_\_  
Carlos Pitanga, Chief Operating Officer Assurance – Americas

Original Registration Date: 2015-10-27

Latest Revision Date: 2018-10-12

Effective Date: 2018-10-27

Expiry Date: 2021-10-26

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Certificate No: **FM 639901**

Location	Registered Activities
HP Inc. 11445 Compaq Center Drive, Bldg. CCM03 Houston Texas 77070 USA	Design, development, marketing, procurement, sales order fulfillment, supply chain management, and support of printers, personal computers, mobile devices, and accessories.
HP - HPI Bentonville AR 2601 SE J. Street Bentonville Arkansas 72712 USA	Perform various integration, networking and deployment services for both internal and external customers. Provide customized solution to meet the individual needs of our customers and insure that the proper solution is implemented.
HP - HPI Boise 11311 Chinden Boulevard Boise Idaho 83714 USA	The Quality Organization, Supplier Management, and Supply Chain processes for LaserJet Printers, Copiers, PageWide Array and Scanners.
HP - HPI Ottawa Canada 2855 Swansea Crescent Ottawa Ontario K1G 3L6 Canada	Perform various integration, networking and deployment services for both internal and external customers. Provide customized solution to meet the individual needs of our customers and insure that the proper solution is implemented.
HP Inc. Computing & Printing Mexico Av. Vasco de Quiroga 2999 Peña Blanca Santa Fe México/D.F. Del. Álvaro Obregón Distrito Federal 01210 Mexico	Sales and support services for imaging, printing, and personal computing products as well as its support channel processes.
HP Inc. Computing and Printing Global Services Mexico S. de R.L. de C.V. Camino al ITESO 8270 Col. El Mante Zapopan Jalisco 45609 Mexico	Supply chain processes for personal computers, digital imaging and printing equipment, and other related HP products, accessories and consumables.

Original Registration Date: 2015-10-27

Latest Revision Date: 2018-10-12

Effective Date: 2018-10-27

Expiry Date: 2021-10-26

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Certificate No: **FM 639901**

Location

HP- HPI Shanghai  
Building C, 4/F,  
2727 Jinke Road  
Pudong  
Shanghai  
201203  
China

Registered Activities

The Quality Organization, Supplier Management, and Supply Chain processes for LaserJet Printers and Scanners.



Original Registration Date: 2015-10-27

Latest Revision Date: 2018-10-12

Effective Date: 2018-10-27

Expiry Date: 2021-10-26

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# Microsoft

Hardware certification report **Approved**

Private product ID: 14397178456687614  
Shared product ID: 1152921504607303863  
Submission ID: 1152921504626828598  
Submission date: 7/28/2017  
Completion date: 7/28/2017  
Company: HP Inc.  
Product name: HP 240 G6 Notebook PC - Colts6U 1.0 UMA  
Category: System  
Product type: Laptop  
Qualification level: Certified for Microsoft Windows 10 Client family version 1703, x64  
Marketing name: HP 240 G6 Notebook PC  
HP 246 G6 Notebook PC

Microsoft  
Certified